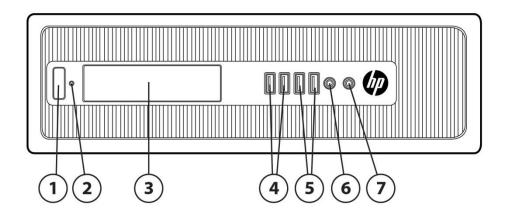
### Overview

### HP ProDesk 400 G2 Small Form Factor Business PC1



- 1. Power button
- 2. PC status LED
- 3. 3.5" external drive bay; used for installing a Media Card Reader
- 4. (2) USB 2.0 ports (black)
- 5. (2) USB 3.0 ports (blue)
- 6. 3.5mm microphone jack
- 7. 3.5mm headphone output

#### **Not Shown**

Slimline drive bay supporting an optical disk drive (located behind removable bezel)

#### Slots

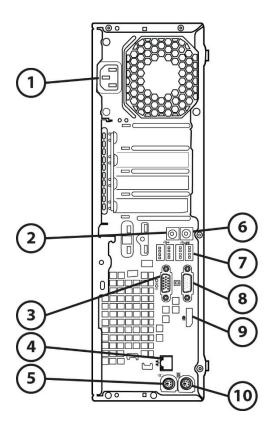
- (1) PCI 3.0 Express x16 Graphics Connectors
- (3) PCI Express 2.0 x1 Accessory Connectors

### Bays

- (1) 2.5" Internal Storage Drive Bay
- (2) 3.5" Internal Storage Drive Bay

<sup>&</sup>lt;sup>1</sup>THIS PRODUCT IS ONLY FOR APJ REGION

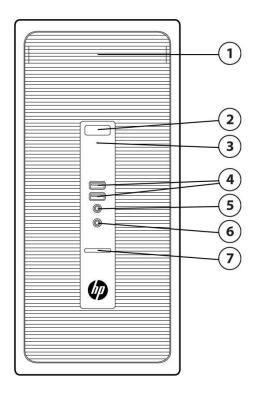
### Overview



- 1. Power Cord Connector
- 2. Line-In Audio Connector (blue)
- 3. RS-232 Serial Connector
- 4. RJ-45 Network Connector
- 5. PS/2 Mouse Connector (green)
- 6. Line-Out Connector for powered audio devices (green)
- 7. (4) USB 2.0 Ports (black)
- 8. VGA Monitor Connector
- 9. DisplayPort 1.2
- 10. PS/2 Keyboard Connector (purple)

### Overview

### HP ProDesk 400 G2 Microtower Business PC12



- 1. Slimline Drive Bay supporting an optical disk drive (optional)
- 2. Power Button
- 3. Hard Drive Activity Light
- 4. (2) USB 3.0 Ports (blue)
- 5. 3.5mm Microphone Jack
- 6. 3.5mm Headphone Output
- 7. SD Reader (optional)

### Not Shown

(.) - . . .

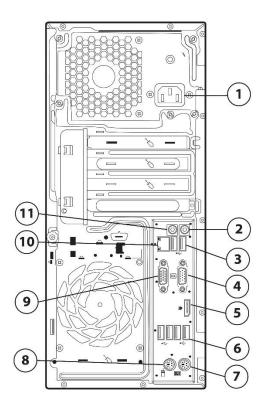
- Slots (1) PCI 3.0 Express x16 Graphics Connectors
  - (3) PCI Express 2.0 x1 Accessory Connectors

Bays (2) 3.5" Internal Storage Drive Bays (1 bay can be configured as 2.5")

<sup>1</sup> THIS PRODUCT IS ONLY FOR EMEA AND APJ REGION

<sup>2</sup> Some features are different according to different models: "HP ProDesk 400 G2 MT" or "HP ProDesk 400 G2 MT (TPM, DisplayPort and 2 extra USB)".

### **Overview**



- 1. Power Cord Connector
- 2. Line-Out Connector for powered audio devices (green)
- 3. (2) USB 2.0 Ports (black)
- 4. VGA Monitor Connector
- 5. DisplayPort 1.2
- (4) USB 2.0 Ports (black)

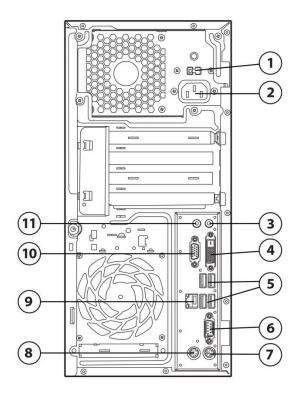
- 7. PS/2 Keyboard Connector (purple)
- 8. PS/2 Mouse Connector (green)
- 9. RS-232 Serial Connector
- 10. RJ-45 Network Connector
- 11. Line-In Audio Connector (blue)

### **Not Shown**

Parallel Port (optional); 2<sup>nd</sup> RS-232 Serial Port (optional)

\* Only for model "HP ProDesk 400 G2 MT (TPM, DisplayPort and 2 additional USB)"

### **Overview**



- 1. Voltage Select Switch (included on some models only)
- 2. Power Cord Connector
- 3. Line-Out Connector for powered audio devices (green)
- 4. DVI-D Monitor Connector
- 5. (4) USB 2.0 Ports (black)
- 6. RS-232 Serial Connector
  - **Not Shown**

Parallel Port (optional); 2<sup>nd</sup> RS-232 Serial Port (optional)

- 7. PS/2 Keyboard Connector (purple)
- 8. PS/2 Mouse Connector (green)
- 9. RJ-45 Network Connector
- 10. VGA Monitor Connector
- 11. Line-In Audio Connector (blue)

\*Only for model "HP ProDesk 400 G2 MT"

Overview

### **AT A GLANCE**

- Choice of two chassis form factors: Small Form Factor and Microtower
- Expandable, upgradable chassis and system board
- Intel® H81 Express chipset supporting Intel 4th generation Core processors, featuring integrated Intel HD Graphics
- Processor support up to 84W
- HP developed and engineered UEFI BIOS supporting security, manageability and software image stability
- Realtek RTL8151GH-CG GbE LOM integrated network connection
- Up to 16GB DDR3 Synchronous Dynamic Random Access Memory (SDRAM)
- Multi-independent monitor support via VGA, DVI-D (Only for model "HP ProDesk 400 G2 MT") and DisplayPort 1.2 (Only for model "HP ProDesk 400 G2 MT (TPM, DisplayPort and 2 extra USB)") video interfaces
- Discrete graphics options available for all platforms
- DTS Sound+™ audio management software
- Standard and high efficiency energy saving power supply options
- ENERGY STAR® certified models certified EPEAT® Gold

NOTE: See important legal disclosures for all listed specs in their respective features sections.



### Standard Features and Configurable Components

### **PROCESSORS\***

Intel® 4th Generation Core™ i7 Processors  Intel® Core™ i7-4790 Processor  Up to 4.0 GHz Max. Turbo Frequency (3.6 GHz base frequency)  8 MB cache, 4 cores, 8 threads Intel HD Graphics 4600  Supports DDR3 memory up to 1600 MT/s data rate	MT/SFF X
Intel® Core™ i7-4790s Processor Up to 4.0 GHz Max. Turbo Frequency (3.2 GHz base frequency) 8 MB cache, 4 cores, 8 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate	X
Intel® Core™ i7-4770 Processor Up to 3.9 GHz Max. Turbo Frequency (3.4 GHz base frequency) 8 MB cache, 4 cores, 8 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate	X
Intel® Core™ i7-4771 Processor  Up to 3.9 GHz Max. Turbo Frequency (3.5 GHz base frequency)  8 MB cache, 4 cores, 8 threads Intel HD Graphics 4600  Supports DDR3 memory up to 1600 MT/s data rate	X
Intel® Core™ i7-4770S Processor  Up to 3.9 GHz Max. Turbo Frequency (3.1 GHz base frequency)  8 MB cache, 4 cores, 8 threads Intel HD Graphics 4600  Supports DDR3 memory up to 1600 MT/s data rate	X
Intel® 4th Generation Core™ i5 Processors  Intel® Core™ i5-4690 Processor  Up to 3.9 GHz Max. Turbo Frequency (3.5 GHz base frequency)  6 MB cache, 4 cores, 4 threads Intel HD Graphics 4600  Supports DDR3 memory up to 1600 MT/s data rate	MT/SFF X
Intel® Core™ i5-4690S Processor Up to 3.9 GHz Max. Turbo Frequency (3.2 GHz base frequency) 6 MB cache, 4 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate	X
Intel® Core™ i5-4590 Processor Up to 3.7 GHz Max. Turbo Frequency (3.3 GHz base frequency) 6 MB cache, 4 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate	х



## Standard Features and Configurable Components

Intel® Core™ i5-4590S Processor Up to 3.7 GHz Max. Turbo Frequency (3.0 GHz base frequency) 6 MB cache, 4 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate	X	
Intel® Core™ i5-4570 Processor Up to 3.6 GHz Max. Turbo Frequency (3.2 GHz base frequency) 6 MB cache, 4 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate	X	
Intel® Core™ i5-4570S Processor  Up to 3.6 GHz Max. Turbo Frequency (2.9 GHz base frequency)  6 MB cache, 4 cores, 4 threads Intel HD Graphics 4600  Supports DDR3 memory up to 1600 MT/s data rate	X	
Intel® Core™ i5-4670 Processor Up to 3.8 GHz Max. Turbo Frequency (3.4 GHz base frequency) 6 MB cache, 4 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate	X	
Intel® Core™ i5-4670S Processor  Up to 3.8 GHz Max. Turbo Frequency (3.1 GHz base frequency)  6 MB cache, 4 cores, 4 threads Intel HD Graphics 4600  Supports DDR3 memory up to 1600 MT/s data rate	X	
Intel® Core™ i5-4430 Processor  Up to 3.2 GHz Max. Turbo Frequency (3.0 GHz base frequency)  6 MB cache, 4 cores, 4 threads Intel HD Graphics 4600  Supports DDR3 memory up to 1600 MT/s data rate	X	
Intel® Core™ i5-4430s Processor  Up to 3.2 GHz Max. Turbo Frequency (2.7 GHz base frequency)  6 MB cache, 4 cores, 4 threads Intel HD Graphics 4600  Supports DDR3 memory up to 1600 MT/s data rate	X	
Intel® 4th Generation Core™ i3 Processors  Intel® Core™ i3-4370 Processor  Up to 3.8 GHz Base Frequency  4 MB cache, 2 cores, 4 threads Intel HD Graphics 4600  Supports DDR3 memory up to 1600 MT/s data rate	MT/SFF X	
Intel® Core™ i3-4360 Processor	X	



X

X

X

X

X

X

X

MT/SFF

X

# QuickSpecs

### Standard Features and Configurable Components

Up to 3.7 GHz Base Frequency 4 MB cache, 2 cores, 4 threads Intel HD Graphics 4600 Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i3-4350 Processor
Up to 3.6 GHz Base Frequency
4 MB cache, 2 cores, 4 threads
Intel HD Graphics 4600
Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i3-4170 Processor
Up to 3.7 GHz Base Frequency
3 MB cache, 2 cores, 4 threads
Intel HD Graphics 4400
Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i3-4160 Processor
Up to 3.6 GHz Base Frequency
3 MB cache, 2 cores, 4 threads
Intel HD Graphics 4400
Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i3-4150 Processor
Up to 3.5 GHz Base Frequency
3 MB cache, 2 cores, 4 threads
Intel HD Graphics 4400
Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i3-4340 Processor
Up to 3.6 GHz Max. Turbo Frequency (3.6 GHz base frequency)
4 MB cache, 2 cores, 4 threads
Intel HD Graphics 4600
Supports DDR3 memory up to 1600 MT/s data rate

<u>Intel® Core™ i3-4330 Processor</u>
Up to 3.5 GHz Max. Turbo Frequency (3.5 GHz base frequency)
4 MB cache, 2 cores, 4 threads
Intel HD Graphics 4600
Supports DDR3 memory up to 1600 MT/s data rate

Intel® Core™ i3-4130 Processor
Up to 3.4 GHz Max. Turbo Frequency (3.4 GHz base frequency)
3 MB cache, 2 cores, 4 threads
Intel HD Graphics 4400
Supports DDR3 memory up to 1600 MT/s data rate

Intel® Pentium Processors
Intel® Pentium G3470 Processor
Up to 3.6 GHz Base Frequency
3 MB cache, 2 cores, 2 threads

### Standard Features and Configurable Components

Intel HD Graphics Supports DDR3 memory up to 1600 MT/s data rate X Intel® Pentium G3460 Processor Up to 3.5 GHz Base Frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1600 MT/s data rate Intel® Pentium G3450 Processor X Up to 3.4 GHz Base Frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1600 MT/s data rate Intel® Pentium G3440 Processor X Up to 3.3 GHz Base Frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1600 MT/s data rate X Intel® Pentium G3260 Processor Up to 3.3 GHz Base Frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1333 MT/s data rate Intel® Pentium G3250 Processor X Up to 3.2 GHz Base Frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1333 MT/s data rate Intel® Pentium G3240 Processor X Up to 3.1 GHz Base Frequency 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1333 MT/s data rate X Intel® Pentium G3430 Processor Up to 3.3 GHz Max. Turbo Frequency (3.3 GHz base frequency) 3 MB cache, 2 cores, 2 threads Intel HD Graphics Supports DDR3 memory up to 1600 MT/s data rate X Intel® Pentium G3420 Processor



Up to 3.2 GHz Max. Turbo Frequency (3.2 GHz base frequency)

Supports DDR3 memory up to 1600 MT/s data rate

3 MB cache, 2 cores, 2 threads

Intel HD Graphics

### Standard Features and Configurable Components

Intel® Pentium G3220 Processor  Up to 3.0 GHz Max. Turbo Frequency (3.0 GHz base frequency)  3 MB cache, 2 cores, 2 threads Intel HD Graphics  Supports DDR3 memory up to 1600 MT/s data rate	X
Intel® Celeron Processors	
Intel® Celeron™ G1850 Processor	X
2.9 GHz base frequency 2 MB cache, 2 cores, 2 threads	
Intel HD Graphics	
Supports DDR3 memory up to 1333 MT/s data rate	
Intel® Celeron™ G1840 Processor	x
2.8 GHz base frequency	^
2 MB cache, 2 cores, 2 threads	
Intel HD Graphics Supports DDR3 memory up to 1333 MT/s data rate	
Supports BBNS memory up to 1555 M//S data rate	
Intel® Celeron™ G1830 Processor	X
2.8 GHz base frequency	
2 MB cache, 2 cores, 2 threads Intel HD Graphics	
Supports DDR3 memory up to 1333 MT/s data rate	
Intel® Celeron™ G1820 Processor	X
2.7 GHz base frequency 2 MB cache, 2 cores, 2 threads	
Intel HD Graphics	
Supports DDR3 memory up to 1333 MT/s data rate	

\*Multi-Core is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. 64-bit computing on Intel® architecture requires a computer system with a processor, chipset, BIOS, operating system, device drivers, and applications enabled for Intel® 64 architecture. Processors will not operate (including 32-bit operation) without an Intel® 64 architecture-enabled BIOS. Performance will vary depending on your hardware and software configurations. Intel's numbering is not a measurement of higher performance.

#### **CHIPSET**

Intel® 8 Series (H81 Express) Chipset

### **GRAPHICS\***

\*NOTE: AMD and NVIDIA graphics cards are not available on configurations with the preinstalled Windows 10 operating system. Configurations with the Windows 10 downgrade to Windows 7 operating system will allow for upgrading to Windows 10 with AMD and NVIDIA graphics cards through graphics driver installation from hp.com.

	<u> 1911/3FF</u>
Intel HD Graphics on all models (integrated on processor)	X
AMD Radeon™ HD 8350 (1GB) FH PCIe x16*	MT only
AMD Radeon™ HD 8350 (1GB) PCIe x16	X



MT/CEE

### Standard Features and Configurable Components

AMD Radeon™ HD 8470 (2GB) FH*	MT only
AMD Radeon™ HD 8490 (1GB) PCIe x16	X
NVIDIA® GeForce® GT630 (2GB) FH PCIe x16**	MT only
NVIDIA® NVS™ 310 x16 1st (no cbl)	X
NVIDIA® NVS™ 315 (1GB) PCIe x1	X
AMD Radeon™ R7 240 2GB FH PCIe x16	MT only
AMD Radeon™ R9 255 2GB PCIe x16	MT only

**NOTE**: HD content required to view HD images.

NOTE: Discrete graphics options cannot be configured with 180W power supply and Quad-Core

**Processor** 

### **ADAPTERS AND CABLES**

HP DMS-59 to Dual DisplayPort Cable

HP DMS-59 to Dual DVI Cable

HP DMS-59 to Dual VGA Cable

HP DisplayPort to DisplayPort Cable

HP DisplayPort to DVI-D Adapter

HP DisplayPort to HDMI Adapter

HP DisplayPort To HDMI 1.4 Adapter

HP DisplayPort to VGA Adapter

**HP Serial Port Adapter** 

**HP Parallel Port Adapter** 

**HP DisplayPort Cable** 

### **STORAGE\***

SATA Drives	<u>MT</u>	<u>SFF</u>
2 TB, 7200 RPM, SATA 6.0 Gb/s, SMART IV, 3.5"	X	X
2 TB, 7200 RPM, SATA 6.0 Gb/s, SMART IV, 3.5" - 2 <sup>nd</sup> hard drive	X	X
1 TB, 7200 RPM, SATA 6.0 Gb/s, SMART IV, 3.5"	X	X
1 TB, 7200 RPM, SATA 6.0 Gb/s, SMART IV, 3.5" - 2 <sup>nd</sup> hard drive	X	X
500 GB, 7200 RPM, SATA 6.0 Gb/s, SMART IV, 3.5"	X	X
500 GB, 7200 RPM, SATA 6.0 Gb/s, SMART IV, 3.5" - 2 <sup>nd</sup> hard drive	X	X
500GB, 7200 RPM SATA SED, 2.5" (with 3.5" adapter when installed in MT)	X	X
500GB, 7200 RPM SATA SED, 2.5" (with 3.5" adapter when installed in MT) - $2^{nd}$ hard drive	X	х
500GB 2.5 FIPS 140-2 SED HDD (with 3.5" adapter when needed)		X
Hybrid Drives	<u>MT</u>	<u>SFF</u>
1 TB SATA 6G 2.5" (8 GB cache) SSHD Drive (with 3.5" adapter when installed in MT)	X	Х
1 TB SATA 6G 2.5" (8 GB cache) SSHD Drive (with 3.5" adapter when installed in MT) - 2 <sup>nd</sup> hard drive	X	x



<sup>\*</sup>Available only in China region

<sup>\*\*</sup>Not configurable with 180W PSU

## Standard Features and Configurable Components

500 GB SATA 6G 2.5" (8GB cache) SSHD Drive (with 3.5" adapter when installed in MT)	x	X
500 GB SATA 6G 2.5" (8GB cache) SSHD Drive (with 3.5" adapter when installed in MT) - $2^{nd}$ hard drive	x	X
500 GB SATA 6G 2.5" (8GB cache) SSHD Drive w/caddy	X	X
500 GB SATA 6G 2.5" (8GB cache) SSHD Drive w/caddy- 2 <sup>nd</sup> hard drive	X	X
Solid State Drives	<u>MT</u>	<u>SFF</u>
120GB SATA 2.5 Non-SED SSD (with 3.5" adapter when needed)	<u>X</u>	<u>X</u>
180GB SATA 2.5 Non-SED SSD (with 3.5" adapter when needed)	<u>X</u>	<u>X</u>
128 GB SATA 6G 2.5" SSD (with 3.5" adapter when installed in MT)	X	X
128 GB SATA 6G 2.5" SSD (with 3.5" adapter when installed in MT) - 2 <sup>nd</sup> hard drive	X	X
128 GB SATA 6G 2.5" SSD w/caddy	X	
128 GB SATA 6G 2.5" SSD w/caddy - 2 <sup>nd</sup> hard drive	X	
128GB SATA 2.5 SSD TLC Non-SED	X	Х
256GB SATA 2.5 SSD TLC Non-SED	X	Х
Self-encrypting Drives	<u>MT</u>	<u>SFF</u>
500GB 7200 RPM SATA 2.5 SED HDD		X
Self-encrypting Solid State Drive	<u>MT</u>	<u>SFF</u>
500GB 2.5" FIPS 140-2 Self-Encrypting (SED) Solid State Drive		Х
500GB 2.5" FIPS 140-2 Self-Encrypting (SED) Solid State Drive - 2nd hard drive		X
500GB 2.5" FIPS 140-2 w/ca Self-Encrypting (SED) Solid State Drive	X	
500GB 2.5" FIPS 140-2 w/ca Self-Encrypting (SED) Solid State Drive - 2nd hard drive	X	
256GB SATA 2.5" Opal2 Self-Encrypting (SED) Solid State Drive SSD		X
256GB SATA 2.5" Opal2 Self-Encrypting (SED) Solid State Drive - 2nd hard drive		х
256GB SATA 2.5" w/ca Opal2 Self-Encrypting (SED) Solid State Drive	X	
256GB SATA 2.5" w/ca Opal2 Self-Encrypting (SED) Solid State Drive - 2nd hard drive	X	
256 GB SATA 2.5" Self-Encrypting (SED) Solid State Drive (with 3.5" adapter when installed in MT)	Х	Х
256 GB SATA 2.5" Self-Encrypting (SED) Solid State Drive (with 3.5" adapter when installed in MT) - $2^{nd}$ hard drive	X	х
256 GB SATA 2.5" w/caddy Self-Encrypting (SED) Solid State Drive	X	
256 GB SATA 2.5" w/caddy Self-Encrypting (SED) Solid State Drive - 2nd hard drive	X	
180GB SATA 2.5" Opal1 Self-Encrypting (SED) Solid State Drive (Pro 1500)		
180GB SATA 2.5" Opal1 Self-Encrypting (SED) Solid State Drive (Pro 1500) - 2 <sup>nd</sup> hard drive		
180GB SATA 2.5" Opal1 Self-Encrypting (SED) Solid State Drive (Pro 1500) w/caddy	X	
180GB SATA 2.5" Opal1 Self-Encrypting (SED) Solid State Drive (Pro 1500) w/caddy - 2 <sup>nd</sup> hard drive	x	
128GB SATA 2.5" Opal2 Self-Encrypting (SED) Solid State Drive		Х
128GB SATA 2.5" Opal2 Self-Encrypting (SED) Solid State Drive- 2nd hard drive		X
128GB SATA 2.5" Opal2 Self-Encrypting (SED) Solid State Drive w/ caddy	X	



### Standard Features and Configurable Components

128GB SATA 2.5" Opal2 Self-Encrypting (SED) Solid State Drive w/ caddy - 2 <sup>nd</sup> hard drive	X	
120GB SATA 2.5" Opal1 Self-Encrypting (SED) Solid State Drive (Pro 1500)		X
120GB SATA 2.5" Opal1 Self-Encrypting (SED) Solid State Drive (Pro 1500) - 2 <sup>nd</sup> hard drive		
120GB SATA 2.5" Opal1 Self-Encrypting (SED) Solid State Drive (Pro 1500) w/ caddy	X	
120GB SATA 2.5" Opal1 Self-Encrypting (SED) Solid State Drive (Pro 1500) w/ caddy - 2 <sup>nd</sup> hard drive	X	X
120GB SATA 2.5 Opal2 SED SSD (with 3.5" adapter when needed)	X	X
180GB SATA 2.5 Opal2 SED SSD (with 3.5" adapter when needed)	X	X

#### Frame/Carrier

HP Slim Removable SATA HDD Frame/Carrier

#### **Optical Disc Drive**

Slim DVD-ROM

Slim BDXL Blu-ray Writer

Slim SuperMulti

#### Media Card Reader\*\*

Media Card Reader		X
SD Reader	X	

\*NOTE: For hard drives and solid state drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 16 GB (for Windows 7) and 36 GB (for Windows 8.1/10) of system disk is reserved for the system recovery software.

### **MEMORY**

Form Factor	Туре	Maximum	# of Slots
Small Form Factor	DDR3 non-ECC Up to 1600 MT/s	16 GB	2 DIMM
Microtower	DDR3 non-ECC	16 GB	2 DIMM

**NOTE**: For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system. Memory modules support data transfer rates up to 1600 MT/s; actual data rate is determined by the system's configured processor. See processor specifications for supported memory data rate.

### **NETWORKING/COMMUNICATIONS**

### Ethernet (RJ-45)

Realtek RTL8151GH-CG GbE LOM (standard)

Intel Ethernet I210-T1 PCIe x1 Gb Network Interface Card (optional)

#### Wireless\*

Intel® Dual Band Wireless-N 7260 802.11 a/b/g/n PCI Express (optional)



<sup>\*\*</sup>Card sold separately

### Standard Features and Configurable Components

HP WLAN 802.11 a/b/g/n 2x2 Dual Band PCIe x1 WLAN (optional) Intel 7260 802.11 a/b/g/n PCIe x1 WLAN Card (optional)

\* Wireless access point and Internet service required and not included. Availability of public wireless access points limited.

### **AUDIO/MULTIMEDIA**

HD audio with Realtek ALC221 codec (all ports are stereo)

DTS Sound+™ audio management technology

Microphone and headphone front ports (3.5mm)

Line-out and Line-In rear Ports (3.5mm)

Multi-streaming capable

Internal speaker (standard)

### **KEYBOARDS AND POINTING DEVICES**

#### Keyboard

HP PS/2 Keyboard

**HP USB Keyboard** 

USB Smart Card (CCID) Keyboard

HP USB and PS/2 Washable Keyboard

HP Wireless Keyboard and Mouse Combo\*

HP USB PS/2 Washable W8 Keyboard

**HP USB Antimicrobial Keyboard** 

\*Keyboard contains 25% post-consumer recycled plastic material

#### Mice

HP PS/2 Mouse

**HP USB Mouse** 

HP USB 1000dpi Laser Mouse

HP USB and PS/2 Washable Mouse

**HP USB Antimicrobial Mouse** 

### **HP BIOSphere**

Key features of the HP BIOS include:

- Deployment and manageability HP BIOS provides several technologies that help integrate the HP ProDesk 400 G2 MT Business PC into the enterprise, such as PXE, and F10 Setup support for 12 languages.
- Support UEFI specification 2.3.1
- Thermal and power management The HP BIOS provides and enables thermal and power management technologies so component temperatures are managed for high reliability and to assist in operating the HP Business Desktop computer in any enterprise environment.
- Thermal Controlled Fans Automatic or manual controlled fan speeds for cooling and acoustic performance Serviceability HP BIOS provides diagnostic and detailed service information.
- Upgrades and recovery HP BIOS provides numerous ways to upgrade HP Business Desktop computers, including BIOS updates from within DOS (DOSFlash), BIOS updates from within Windows (HPQFlash), HP Client Manager, and



### Standard Features and Configurable Components

fail-safe recovery (Emergency Boot Block Recovery). In addition, the HP Business Desktop BIOS Utilities tool enables replicated BIOS setup throughout the Enterprise; it is available from within the BIOS F10 setup and from the support website.

- HP BIOS uses PKI signing of the BIOS for trusted BIOS upgrades and recovery.
- Serviceability HP BIOS provides diagnostic and detailed service information.

#### Additional HP BIOS Features:

- Power-On password Helps prevent an unauthorized user from powering on the system.
- Administrator password Also known as the setup password, this helps prevent unauthorized changes to the system configuration. If the administrator password is not known, the BIOS version cannot be changed and changes cannot be made to BIOS settings using F10 setup or under the OS.
- Advanced Configuration and Power Interface (ACPI) Represents a significant innovation in power and
  configuration management, allowing operating systems and applications to manage power based on activity and
  usage. HP Pro models use ACPI to provide power conservation features.
- S5 Max Power Savings setting supports EU Lot6 requirement and allows the computer to power down below 1W is S5 (when turned off). When S5 Max Power Savings feature is enabled power to slots is turned off along with WOL functionality.
- Master Boot Record Security Helps to prevent changes and/or infections to the Master Boot Record caused by viruses or malicious code.
- HP BIOS Protection prevents unauthorized updates or changes to the BIOS due to malware, viruses, or malicious BIOS updates. Based on NIST SP800-147 policy guidelines.

\*BIOS Absolute Persistence module is shipped turned off, and will be activated when customers purchase and activate a subscription. Service may be limited. Check with Absolute for availability outside the U.S. The optional subscription service of Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit: http://www.absolute.com/company/legal/agreements/computrace-agreement. If Data Delete is utilized, the Recovery Guarantee payment is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either create a PIN or purchase one or more RSA SecurID tokens from Absolute Software.

SECURITY	<u>MT</u>	<u>SFF</u>
Trusted Platform Module,SLB9660TT1.2FW4.40 (TPM) 1.2 (Common Criteria EAL4+ certified) * Only for model "HP ProDesk 400 G2 MT (TPM, DisplayPort and 2 extra USB)"	X	х
SATA port disablement (via BIOS)	X	X
Drivelock	N/A	N/A
RAID configurations	N/A	N/A
Intel® Identify Protection Technology (IPT) <sup>1</sup>	N/A	N/A
Serial, parallel, USB enable/disable (via BIOS)	X	X
Optional USB Port Disable at factory (user configurable via BIOS)	X	X
Removable media write/boot control	X	X
Power-On password (via BIOS)	X	X
Administrator password (via BIOS)	X	X

<sup>&</sup>lt;sup>1</sup> Models configured with Intel Core processors have the ability to utilize advanced security protection for online transactions. IPT, used in conjunction with participating web sites, provides double identity authentication by adding a hardware component in addition to the usual user name and password. IPT is initialized through an HP Client Security module.



### Standard Features and Configurable Components

HP Chassis (1 bay) Security Kit	X	N/A
Solenoid Hood Lock / Sensor	N/A	N/A
Support for chassis padlocks and cable lock devices	X	Х

### **ENVIRONMENTAL & REGULATORY**

ENERGY STAR® certified models available

EPEAT® registered where applicable/supported. EPEAT registration varies by country. See <a href="http://www.epeat.net">http://www.epeat.net</a> for registration status by country.

Low halogen (chassis, all internal components and modules)\*

TAA compliant models available

For accessibility information on HP products, please visit: http://www.hp.com/accessibility.

\*External power supplies, power cords, cables and peripherals are not Low Halogen. Service parts obtained after purchase may not be Low Halogen.

#### **PORTS**

### I/O Ports - Standard

	<u>MT</u>	<u>SFF</u>
USB 2.0	6 (rear) * Only for model "HP ProDesk 400 G2 MT (TPM, DisplayPort and 2	2 (front); 4 (rear)
	extra USB)"	
	4 (rear) *Only for model "HP ProDesk 400 G2 MT"	
USB 3.0	2 (front)	2 (front)
Serial (RS-232)	1	1
PS/2	1 keyboard (purple) 1 mouse (green)	1 keyboard (purple) 1 mouse (green)
Video	1 VGA	1 VGA
	1-DisplayPort 1.2 * Only for model "HP ProDesk 400 G2 MT (TPM, DisplayPort and 2 extra USB)"	1-DisplayPort 1.2
	1 DVI-D *Only for model "HP ProDesk 400 G2 MT"	
	100 GE 111	

**NOTE:** When configured with an Intel Celeron, Pentium or 4th generation Intel Core i3 CPU only two of the available video output ports are active

Audio	Front:	Front: headphone/mic
	headphone/mic	Rear: line in/out
	Rear: line in/out	3.5mm diameter
	3.5mm diameter	
RJ-45 Network Interface	1	1

### Standard Features and Configurable Components

<u>I/O Ports – Optional</u>	<u>MT</u>	<u>SFF</u>
2nd Serial (RS-232)	1	1
Parallel	1	1
PCI Express x1 (v2.0)	3 4.2" full height 6.6" length 10W max. power	3
PCI Express x16 (v2.0)	1 4.2" full height 6.6" length 75W max. power	1

#### **BAYS**

(4 total – 2 external, 2 internal)	<u>MT</u>	<u>SFF</u>
External, SD reader	1	1
External, Slimline ODD	1	1
2.5" internal storage drive	N/A	1
3.5" internal storage drive	2*	1

<sup>\*</sup>One bay can be configured as a 2.5"

### **SERVICE AND SUPPORT**

On-site Warranty <sup>1</sup>: One-year (1-1-1) limited warranty delivers one year of on-site, next business day <sup>2</sup> service for parts and labor and includes free telephone support <sup>3</sup> 24 x 7. One-year onsite and labor are not available in all countries. Service offers terms up to 5 years by choosing a Care Pack. To choose the right level of service for your HP product, visit HP Care Pack Central: www.hp.com/go/cpc

**NOTE** 1: Terms and conditions may vary by country. Certain restrictions and exclusions apply. Other warranty variations may be offered in your region.

**NOTE** 2: On-site service may be provided pursuant to a service contract between HP and an authorized HP third-party provider, and is not available in certain countries. Global service response times are based on commercially reasonable best effort and may vary by country.

**NOTE** 3: Technical telephone support applies only to HP-configured and third-party HP qualified hardware and software. Toll-free calling and 24 x 7 support may not be available in some countries.



### **Technical Specifications - Graphics**

### **OPERATING SYSTEMS**

#### Preinstalled (Windows)

Windows 10 Pro 64\*

Windows 10 Home 64\*

Windows 8.1 Pro 64\*

Windows 8.1 64\*

Windows 7 Professional 64 (available through downgrade rights from Windows 10 Pro)\*\*

Windows 7 Professional 32 (available through downgrade rights from Windows 10 Pro)\*\*

Windows 7 Professional 64 (available through downgrade rights form Windows 8.1 Pro)\*\*\*

Windows 7 Professional 32 (available through downgrade rights form Windows 8.1 Pro)\*\*\*

Windows 7 Professional 64\*

Windows 7 Professional 32\*

#### Pre-installed (Other)

FreeDOS 2.0

Novell SUSE Linux Enterprise Desktop 11

#### **Web Support Only**

Windows 10 Pro 64

Windows 10 Home 64

Windows 8.1 Pro 64

Windows 8.1 64

Windows 7 Professional 64 (available through downgrade rights from Windows 10 Pro)

Windows 7 Professional 32 (available through downgrade rights from Windows 10 Pro)

Windows 7 Professional 64 (available through downgrade rights form Windows 8.1 Pro)

Windows 7 Professional 32 (available through downgrade rights form Windows 8.1 Pro)

Windows 7 Professional 64

Windows 7 Professional 32

Windows 10 Enterprise 64

Windows 8.1 Enterprise 64

Windows 7 Enterprise 64

Windows 7 Enterprise 32

\*NOTE: Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows 10 is automatically updated, which is always enabled. ISP fees may apply and additional requirements may apply over time for updates. See http://www.microsoft.com.

\*\*This system is preinstalled with Windows 7 Pro software and also comes with a license and media for Windows 10 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

\*\*\*This system is preinstalled with Windows 7 Pro software and also comes with a license and media for Windows 8.1 Pro software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

SOFTWARE COMPONENTS AND APPLICATIONS WITH WINDOWS			
Included	Windows 7	Windows 8.1	Windows 10



## **Technical Specifications - Graphics**

BIOS	HP BIOS Protection <sup>2</sup> BIOS Update via Network Power On Authentication  Absolute Persistence Module <sup>4</sup>	BIOS Update via Network Power On Authentication Measured Boot Secure Boot Absolute Persistence	HP BIOSphere <sup>1</sup> HP BIOS Protection <sup>2</sup> BIOS Update via Network Power On Authentication Measured Boot Secure Boot Absolute Persistence Module <sup>4</sup>
Multimedia	CyberLink Power2Go (Secure	-	CyberLink Power DVD, BD CyberLink Power2Go (Secure Burn)

	Windows 7	Windows 8.1	Windows 10
Communication	Intel® Wireless Display (WiDi) Software for Windows <sup>5</sup>	Intel® Wireless Display (WiDi) Software for Windows <sup>5</sup>	Intel® Wireless Display (WiDi) Software for Windows <sup>5</sup>
HP Value Add	HP ePrint Driver <sup>7</sup> HP Recovery Manager HP Support Assistant HP Recovery Disc Creator	HP Recovery Manager HP Support Assistant HP Recovery Disc Creator	HP ePrint Driver7 HP Recovery Manager HP Support Assistant Windows 10 Welcome App HP Recovery Disc Creator
3 <sup>rd</sup> Party	Foxit PhantomPDF Express for HP	Foxit PhantomPDF Express for HP	Foxit PhantomPDF Express for HP
Microsoft Products	Buy Office Bing Search Skype	Buy Office Bing Search Skype	Buy Office Bing Search Skype
Manageability		HP System Software Manager (SSM) <sup>8</sup>	HP Drive Packs <sup>8</sup> HP SoftPaq Download Manager (SDM) HP System Software Manager (SSM) <sup>8</sup> HP Client Catalog <sup>8</sup>



### **Technical Specifications - Graphics**

	HP CIK for Microsoft SCCM <sup>8</sup> LANDESK Management <sup>9</sup> HP BIOS Config Utility (BCU) <sup>8</sup>	HP CIK for Microsoft SCCM <sup>8</sup> LANDESK Management <sup>9</sup> HP BIOS Config Utility (BCU) <sup>8</sup>	HP CIK for Microsoft SCCM <sup>8</sup> LANDESK Management <sup>9</sup> HP BIOS Config Utility (BCU) <sup>8</sup> Discover HP Touchpoint Manager
For more informat	ion on HP Client Management Sol	utions refer to: http://www.hp.	com/go/clientmanagement.
	Windows 7	Windows 8.1	Windows 10
Security	HP Device Access Manager HP Drive Encryption <sup>10</sup> HP Disk Sanitizer External Edition HP Security Manager Microsoft Security Essentials <sup>11</sup>	Edition	HP Drive Encryption <sup>10</sup> HP Disk Sanitizer External Edition HP Security Manager Microsoft Defender
Standard	Smart Card Reader Security lock slot Preboot Authentication	Smart Card Reader Security lock slot Preboot Authentication	Smart Card Reader Security lock slot Preboot Authentication

**NOTE**: The Absolute Persistence agent is shipped turned off, and must be activated by customers when they purchase a subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S.

For more information on HP Client Security Software Suite, refer to http://www.hp.com/go/clientsecurity.

#### Footnotes:

- 1 Available only on business PCs with HP BIOS.
- 2 May require a manual recovery step if all copies of BIOS are compromised or deleted
- 4 Absolute agent is shipped turned off, and will be activated when customers activate a purchased subscription. Subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. The Absolute Recovery Guarantee is a limited warranty. Certain conditions apply. For full details visit:
- http://www.absolute.com/company/legal/agreements/ computrace-agreement. Data Delete is an optional service provided by Absolute Software. If utilized, the Recovery Guarantee is null and void. In order to use the Data Delete service, customers must first sign a Pre-Authorization Agreement and either obtain a PIN or purchase one or more RSA SecurID tokens from Absolute Software.
- 5 Integrated Intel® Wi-Di Display is available on select configurations only and requires a separate projector, TV or monitor with an integrated or external Wi-Di receiver. For more information on Intel® Wi-Di Display visit http://www.intel.com/qo/wirelessdisplay

7 Requires an Internet connection to HP web-enabled printer and HP ePrint account registration (for a list of eligible printers, supported documents and image types and other HP ePrint details, see www.hp.com/go/eprintcenter). Requires optional broadband module. Broadband use requires separately purchased service contract. Check with service provider for coverage and availability in your area. Separately purchased data plans or usage fees may apply. Print times and connection speeds may vary.

8 Not preinstalled, however available on manageability website.

9 Subscription required.



### **Technical Specifications - Graphics**

10 Requires Windows. Data is protected prior to Drive Encryption login. Turning the PC off or into hibernate logs out of Drive Encryption and prevents data access.

11 Opt in and internet connection required for updates.



## **Technical Specifications - Graphics**

Intel HD Graphics			
VGA Controller	Integrated		
DisplayPort		Multimode capable; supports HDCP, Display Port Audio (2 streams), HBR2 link rates and Multi-Stream Technology for a maximum of 2 displays (including the integrated panel)	
Bus Type	N/A		
RAMDAC	N/A		
Memory	system memory The amount of memory system memory installed, BIOS settings pre-allocated for graphics use at system at boot time by the BIOS for PAVP (Proto playback of protected video content.  Additional memory is allocated for grap	Additional memory is allocated for graphics as needed using Intel's Dynamic Video Memory Technology (DVMT), to provide an optimal balance between graphics and	
	Microsoft Windows 7	Windows 8.1	
Maximum Graphics Memory	Up to 1.7GB	Up to 1.8GB	
	<b>NOTE</b> : the actual amount of maximum graphics memory can be less than the amounts listed above depending upon your computer's configuration.		
Maximum Color Depth	32 bits/pixel	32 bits/pixel	
Graphics/Video API Support	<ul> <li>4th Generation Core processors:         <ul> <li>The Processor Graphics contains a refresh of the seventh generation graphics core enabling substantial gains in performance and lower power consumption. Up to 16 EU support.</li> <li>Next Generation Intel Clear Video Technology HD Support is a collection of video playback and enhancement features that improve the end user's viewing experience</li></ul></li></ul>		
NOTE: other resolutions may be	Open CL 1.2  Supported Display Resolutions and Refractions and Refraction		
Resolutions may be		may not have been tested and qualified by HP  Refresh Rates	
800x		Kerresn Kates 60 Hz	
1024×		60 Hz	
1152x		60 Hz	
1280x600 60 Hz			



### **Technical Specifications - Graphics**

1280x720	60 Hz
1280x800	60 Hz
1280x960	60 Hz
1280x1024	60 Hz
1360x768	60 Hz
1366x768	60 Hz
1400x1050	60 Hz
1440x900	60 Hz
1600x900	60 Hz
1600x1200*	60 Hz
1680x1050	60 Hz
1920x1080	60 Hz
1920x1200*	60 Hz
1920x1440*	60 Hz
2560x1440*	60 Hz
2560x1600*	60 Hz

<sup>\*</sup> Only supported on displays connected to the external DisplayPort connector.

### AMD Radeon™ HD 8470 Graphics Card

Form Factor	Full Height
Graphics Controller	AMD Radeon™ HD 8470
Core Clock	775MHz
Memory Clock	900MHz
Memory	2GB, DDR3, 64-bit wide
Bus Type	PCIe Gen2
Max. Power	< 30W
Power Source Support	12V and 3.3V
3D API Support	DX11
HDCP Support	Yes
Display Max. Resolution	Digital 2560 x 1600 Analog 2048 x 1536
Supported Graphics APIs	DX11, OpenGL, full 1080p BD (H264) playback in hardware, HDMI 1.4 support

### **Supported Display Resolutions and Refresh Rates**

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Refresh Rates
800 x 600	60 Hz



## **Technical Specifications - Graphics**

1024 x 768	60 Hz
1280 x 720	60 Hz
1280 x 768	60 Hz
1280 x 1024	60 Hz
1360 x 768	60 Hz
1440 x 900	60 Hz
1600 x 900	60 Hz
1680 x 1050	60 Hz
1920 x 1080	60 Hz

NVIDIA® NVS™ 310 Gra	phics Card		
Introduction		Graphics Card is a PCI Express low profile form factor graphics add-in ive low cost graphics solution for the corporate business and	
		graphics card is an ideal solution for customers requiring a small dd-in card for either standard or small form factor PC designs.	
Performance and Features	The NVIDIA® NVS™ 310 capable of supporting	Graphics Card offers 512 MB of ultrafast DDR3 memory and is up to 2 displays.	
	1	supports multimode technology to support connection to DVI-D, VGA h optional adapters in kits NR078AA, FH973AT, BP937AA, AS615AA.	
	For a DisplayPort to Dis	splayPort connections use the optional DisplayPort Cable Kit	
Form Factor	Low Profile: 2.713 × 6.	Low Profile: 2.713 × 6.15 in	
Graphics Controller	NVIDIA® NVS™ 310	NVIDIA® NVS™ 310	
Memory Clock	875MHz	875MHz	
Memory Size	512 MB DDR3	512 MB DDR3	
Memory Bandwidth	14 GB/s	14 GB/s	
Max. Power	19.5W	19.5W	
Display Max. Resolution	Up to 2560 x 1600 (dig	Up to 2560 x 1600 (digital display) per display	
Display Output	Up to 2 displays in the	Up to 2 displays in the following configurations	
	DisplayPort output:	<ul> <li>Drives two DisplayPort enabled digital display at resolutions up to 2560 × 1600 at 60 Hz with reduced blanking, when connected natively using the 2 DisplayPort connectors on the NVS 310 graphics card</li> <li>Supports 2 monitors up to resolution of 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort Multi-Stream topology technology.</li> </ul>	



### **Technical Specifications - Graphics**

VGA display output:	Drives two analog display at resolutions up to 1920 × 1200 at 60 Hz using DisplayPort to VGA cable adaptors
HDMI output:	<ul> <li>NVS 310 is capable of driving two high definition (HD) panels up to resolutions of 1920 × 1080P at 60 Hz using DisplayPort to HDMI cable adaptors</li> </ul>
DVI-D output:	<ul> <li>Drives two digital display at resolutions up to 1920 × 1200 at 60 Hz with reduced blanking using DisplayPort to DVI-D single-link cable adaptors</li> <li>Drives two digital display at resolutions up to 2560× 1600 at 60 Hz with reduced blanking using DisplayPort to DVI-D dual-link cable adaptors</li> </ul>

### **Supported Display Resolutions and Refresh Rates**

**NOTE**: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Maximum Refresh Rates (Hz) by Connection			
	DisplayPort to VGA	DisplayPort to DVI-D	DisplayPort to HDMI	DisplayPort
640 x 480	85	60	60	60
800 x 600	85	60	60	60
1024 x 768	85	60	60	60
1280 x 720	85	60	60	60
1280 x 1024	85	60	60	60
1440 x 900	75	60	60	60
1600 x 1200	60	60	60	60
1680 x 1050	60	60	60	60
1920 x 1080	60-R	60-R	60	60
1920 x 1200	60-R	60-R		60
1920 x 1440				60
2048 x 1536				60
2560 x 1600				60



**Technical Specifications - Graphics** 

Introduction	Get efficient dual-display graphics performance in a PCI Express low-profile graphics card with the NVIDIA® NVS™ 315 PCIe x16 1 GB Graphics Card, an ideal desktop graphics solution for professional business and commercial applications.
Performance and Features	The NVIDIA® NVS™ 315 Graphics Card offers 1 GB of ultrafast DDR3 memory and is capable of supporting up to 2 displays.
	DisplayPort connector supports multimode technology to support connection to DVI-D, VGA and HDMI monitors with optional adapters in kits NR078AA, FH973AT, BP937AA, AS615AA.
	For a DisplayPort to DisplayPort connections use the optional DisplayPort Cable Kit VN567AA.
Form Factor	Low Profile: 2.713 × 6.15 in
Graphics Controller	NVIDIA® NVS™ 315
Memory Clock	875MHz
Memory Size	512 MB DDR3
Memory Bandwidth	14 GB/s
Connectors	DMS-59 , with support for dual VGA, dual DVI or dual Display Port with the appropriate adapter cable
Display Max. Resolution	Up to 2048 x 1536 VGA; 1920 x 1200 DVI; 2560 x 1600 DisplayPort
Display Output	Up to 2 displays in the following configurations
	Dual DVI:     Drives two DVI displays using optional HP DMS59 DVI Dual-head Connector Cable DL139A     Dual DisplayPort:  DisplayPort:
	<ul> <li>Drives two DisplayPort using optional HP DMS-59 to Dual DisplayPort kit XP688AA</li> <li>Dual VGA:</li> <li>Drives two analog using the included HP DMS-59 to Dual VGA Cable</li> </ul>

### **Supported Display Resolutions and Refresh Rates**

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Maximum Refresh Rates (Hz) by Connection	
	Analog Connection	Digital Connection
640 x 480	85	60
720 x 480	85	60
720 x 576	85	60



## **Technical Specifications - Graphics**

800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 768	85	60
1280 x 1024	85	60
1440 x 900	75	60
1600 x 1024	85	60
1600 x 1200	85	60
1680 x 1050	75	60
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	N/A
2048 x 1536	75	N/A
2560 x 1440	N/A	60*
2560 x 1600	N/A	60*
		* Display Port Only

NVIDIA® GeForce® GT630	) Graphics Card
Introduction	The NVIDIA® GeForce® GT630 DP (2GB) PCIe x16 Card Graphics Card provides a full height, PCI Express x16 graphics add-in card solution based on the NVIDIA® Kepler™ Architecture GPU. The card is designed to support three display connections through its DVII, and two DisplayPort connectors.
	An ideal solution for desktop PC customers seeking enhanced 2D and advanced 3D graphics performance, the NVIDIA® GeForce® GT630 DP (2GB) PCIe x16 Cards are an excellent choice for business users who want run multiple displays from a single graphics board. Engage in Web conferencing or video or photo editing, while improving your everyday business PC experience with better graphics and excellent visual display quality.
Performance and Features	The NVIDIA® GeForce® GT630 DP (2GB) PCIe x16 Cards deliver superior PCI Express (PCIe) Gen 3 features including:  • Unprecedented flexibility for new applications and enhanced performance • Support for NVIDIA surround technology • Run multiple displays from a single graphics card • Full 16 lane PCIe Generation 3 bus support with peak bandwidth support • Wireless Display ready for future support
Form Factor	PCle x16 Card
Graphics Controller	NVIDIA® Kepler™ Architecture GPU
Core Clock	875 MHz
Memory Clock	891 MHz
Memory Size	2 GB DDR3 128 bit



### **Technical Specifications - Graphics**

Memory Bandwidth	28.5 GB/s
Display Max. Resolution	2560 x 1600 digital, 2048 x 1536 analog
Display Support	Integrated 400 MHz RAMDAC

### **Supported Display Resolutions and Refresh Rates**

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Maximum Refr	esh Rates (Hz)
	Analog Connection	Digital Connection
640 x 480	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 1024	85	60
1440 x 900	75	60
1600 x 1200	85	60
1680 x 1050	75	60
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	60
2048 x 1536	75	60
2560 x 1600	N/A	60

AMD Radeon™ HD 8350 1GB PCIe x16 DH Graphics Card	
Introduction	Get stable 2D and advanced 3D graphics performance from the AMD Radeon™ HD 8350 1 GB PCIe x16 DH Graphics Card, a low profile, PCI Express x16 graphics add-in card based on the AMD Radeon™ HD 8350 GPU, great for Web conferencing or video and photo editing.
Form Factor	PCie x16
Graphics Controller	AMD Radeon™ HD 8350
Core Clock	GPU engine operates at 523 MHz
Memory	1GB, DDR3, SDRAM
Memory Clock	875 MHz
HDCP Support	Yes
Display Max. Resolution	Digital 1920 x 1200 Analog 2048 x 1536

### **Supported Display Resolutions and Refresh Rates**

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP



## **Technical Specifications - Graphics**

	Analog Connection	Digital Connection
640 x 480	85	60
720 x 480	85	60
720 x 576	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 768	85	60
1280 x 1024	85	60
1440 x 900	75	75
1600 x 1024	85	60
1600 x 1200	85	60
1680 x 1050	75	75-R
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	N/A
2048 x 1536	75	N/A
2560 x 1440	N/A	N/A
2560 x 1600	N/A	N/A

Introduction	Get impressive graphics and high resolution dual-display performance in a low profile, PCI Express x16 graphics add-in card based on the AMD Radeon™ HD 8490 Graphics Processor Improve your everyday PC, Web conferencing, and video or photo editing.
Form Factor	PCie x16
Graphics Controller	AMD Radeon™ HD 8490
Core Clock	GPU engine operates at 875 MHz
Memory	1GB, DDR3, SDRAM
Memory Clock	900 MHz
HDCP Support	Yes
Display Max. Resolution	Digital 2560 x 1600 Analog 2048 x 1536



**Analog Connection** 

**Digital Connection** 

## **Technical Specifications - Graphics**

300 x 200	85	60
320 x 240	85	60
400 x 300	85	60
640 x 480	85	60
720 x 480	85	60
720 x 576	85	60
800 x 600	85	60
1024 x 768	85	60
1280 x 720	85	60
1280 x 768	85	60
1280 x 1024	85	60
1440 x 900	75	75
1600 x 900	85	60
1600 x 1024	85	60
1600 x 1200	85	60
1680 x 1050	75	75-R
1920 x 1080	85	60-R
1920 x 1200	85	60-R
1920 x 1440	85	N/A
2048 x 1536	75	N/A
2560 x 1440	N/A	60
2560 x 1600	N/A	60

AMD Radeon™ R7 240 2GB FH PCIe x16 GFX Graphics Card		
Form Factor	Full Height	
Graphics Controller	AMD Radeon™ R7 240	
Core Clock	730MHz	
Memory Clock	1800MHz	
Memory	2GB, DDR3	
Frame Buffer	128-bit wide frame buffer	
Bus Type	PCI Express 3.0 interface	
Max. Power	32.71 W	
Power Source Support	12V and 3.3V	
HDCP Support	Yes, All digital outputs support HDCP (High-Bandwidth Digital Content Protection)	



## **Technical Specifications - Graphics**

Display Max. Resolution	Digital 1920 x 1200 Analog 2048 x1536
Compliance	Compliant with all listed and with all applicable ACPI, AGP Forum, ANSI, DDWG, HP, Intel, ITU, Microsoft, PCI SIG, SMPTE, and VESA APIs, standards, requirements, implementation guides, and ECRs.

### SUPPORTED DVI-D (DIGITAL) AND DISPLAYPORT DISPLAY MODES

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Refresh Rates
640 x 480	60 Hz
720 x 480	60 Hz
720 x 576	60 Hz
800 x 600	60 Hz
1024 x 768	60 Hz
1280 x 720	60 Hz
1280 x 768	60 Hz
1280 x 1024	60 Hz
1440 x 900	60 Hz, 75 Hz
1600 x 1024	60 Hz
1600 x 1200	60 Hz
1680 x 1050	75 Hz
1920 x 1080	60 Hz

AMD Radeon™ R9 255 2GB PCIe x16 GFX		
Form Factor	PCie x16	
Graphics Controller	AMD Radeon™ R9 255	
Core Clock	900MHz	
Memory Clock	1150MHz	
Memory	2GB, (4 pcs of 4Gb 128Mx32 GDDR5)	
Frame Buffer	128-bit wide frame buffer	
Bus Type	PCI Express 3.0 interface	
Max. Power	N/A	
Power Source Support	12V and 3.3V	
HDCP Support	Yes, All digital outputs support HDCP (High-Bandwidth Digital Content Protection)	



## **Technical Specifications - Graphics**

Display Max. Resolution	Digital 1920 x 1200 Analog 2048 x1536
Compliance	Compliant with all listed and with all applicable ACPI, AGP Forum, ANSI, DDWG, HP, Intel, ITU, Microsoft, PCI SIG, SMPTE, and VESA APIs, standards, requirements, implementation guides, and ECRs.
	Supports Microsoft DirectX 11.1, OpenGL 4.3 and OpenCL 1.2 APIs.

### **SUPPORTED DVI-D (DIGITAL) AND DISPLAYPORT DISPLAY MODES**

NOTE: other resolutions may be available but are not recommended as they may not have been tested and qualified by HP

Resolution	Refresh Rates
320 x 200	60 Hz
320 x 240	60 Hz
400 x 300	60 Hz
480 x 360	60 Hz
512 x 384	60 Hz
640 x 350	60 Hz
640 x 400	60 Hz
640 x 480	60 Hz
720 x 480	60 Hz
720 x 576	60 Hz
800 x 600	60 Hz
1024 x 768	60 Hz
1152 x 864	60 Hz
1280 x 720	60 Hz
1280 x 768	60 Hz
1280 x 960	60 Hz
1280 x 1024	60 Hz
1440 x 900	60 Hz, 75 Hz
1600 x 900	60 Hz
1600 x 1024	60 Hz
1600 x 1200	60 Hz
1680 x 1050	75 Hz
1680 x 1080	60 Hz
1920 x 1080	60 Hz
2560 x 1440	60 Hz
2560 x 1600	60 Hz



### Technical Specifications – Hard Disk and Solid State Storage

### Introduction:

HP Serial Advanced Technology Attachment (SATA) Hard Drives maximize the performance of HP Business PCs by providing the technologies to meet your increasing storage demands with high-capacity drives offering superior reliability and performance.

SATA provides faster data transfer speeds, better system cooling airflow, more bandwidth, more headroom for speed increases in future generations and better data integrity. A next-generation technology, the SATA interface connects hard drives to the PC platform enabling easy aggregation of multiple hard drives into a single PC. This offers you the additional benefits of dedicated bandwidth, the ability to more easily identify device failures and scalability. The HP ProDesk 400 G2 Series Business PC supports the latest SATA 6.0Gb/s specification.

### **SMART IV Technology**

Self Monitoring Analysis and Reporting Technology (SMART) hard drive technology allows hard drives to monitor their own health and to raise flags if imminent failures are predicted. If the drive determines that a failure is imminent, the SMART hard drive technology enables the intelligent manageability or management software to generate a fault alert. While the current versions of SMART hard drives do a good job monitoring the data on the hard drive media, the ever increasing emphasis on reliability and quality has promoted HP to implement SMART IV technology which constantly checks that the data flow from host interface to media and media to host interface is not compromised. This is accomplished by inserting a 2 byte parity code into every 512 byte block in the data path of the hard drive's Cache RAM. This unique parity checking performed by HP's SMART IV technology hard drives, allows for more complete error detection coverage encompassing the entire data path between the host and the hard drive.

Smart IV is also known as IOEDC: I/O Error Detection Code.

#### **Native Command Queuing**

NCQ or Native Command Queuing is a SATA protocol extension that allows the hard drive to have several write or read commands outstanding at the same time. In contrast, normal non-queued operation requires each command to be completed before the next command is issued by the host system. Queuing allows the drive to complete the commands in the order that allows for best overall throughput. It also involves an advanced method of transferring data to or from the host, called First Party Direct Memory Access (FPDMA), which allows the hard drive and the host controller to manage the data transfers for multiple outstanding commands, without involving the host processor. NCQ can contribute to better performance but the results are dependent on many factors, including the access patterns of the various applications and operating system functions that are initiating drive accesses. Enabling NCQ features in the hard drive requires AHCI support from the host system BIOS, controller, and driver. AHCI support is typically implemented in RAID configurations.

**NOTE:** GB = 1 billion bytes. Actual available capacity is less.

HP 256 GB* (non-SED) TLC Solid State Drive			
Unformatted Capacity	256 GB*		
Architecture	Triple Level Cell (TLC) NAND		
Interface	SATA 6 GB/sec		
Dimensions (W x H x D)	2.75 x 0.276 x 3.96 in (6.985 x 0.7 x 10.05 cm)		
Weight	0.1 lb (45 g)		
Bandwidth Performance	Sustained Sequential Read:	Up to 510 MB/s	



## Technical Specifications – Hard Disk and Solid State Storage

Regulations	UL, CSA, EN 60950-2000, CISPR Pub 22 Class B, CNS 13438, AS/NZS CISPR 22:2002 Class B, Korea KCC, CE Mark	
(a coag)	Shock:	1,500 G/1.0 msec
<b>Environmental</b> (all conditions, non-condensing)	Relative Humidity (operating):	5% to 95%
	Operating Temperature:	32° to 158° F (0° to 70° C)
Useful Drive Life	1.2 million device hours**	
rowei	Total power consumption:	160 mW (Active) ; <85 mW; (Idle)
Power	DC power requirement:	Min 4.75 V; Max 5.25 V
Latency	Write:	55ms (TYP)
I about	Read:	55ms (TYP)
	Random Write (4KB):	up to 70K IOPs
	Random Read (4KB):	up to 90K IOPs
	Sustained Sequential Write:	Up to 280 MB/s

<sup>\*</sup> For solid state disk drives, GB means 1 billion bytes. Actual formatted capacity is less. Up to 16GB for Windows 7 and up to 36GB for Windows 8.1 is reserved for system recovery software.\*\* The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.

HP 128 GB* (non-SED) TLC Solid State Drive			
Unformatted Capacity	128 GB*	128 GB*	
Architecture	Triple Level Cell (TLC) NAND	Triple Level Cell (TLC) NAND	
Interface	SATA 6 GB/sec	SATA 6 GB/sec	
Dimensions (W x H x D)	2.75 x 0.276 x 3.96 in (6.985 x 0.7 x 10.0	2.75 x 0.276 x 3.96 in (6.985 x 0.7 x 10.05 cm)	
Weight	0.1 lb (45 g)	0.1 lb (45 g)	
Bandwidth Performance	Sustained Sequential Read:	Up to 510 MB/ss	
	Sustained Sequential Write:	Up to 140 MB/s	
	Random Read (4KB):	up to 90K IOPs	
	Random Write (4KB):	up to 36K IOPs	
Latency	Read:	55ms (TYP)	
	Write:	55ms (TYP)	



### Technical Specifications – Hard Disk and Solid State Storage

Power	DC power requirement:	Min 4.75 V; Max 5.25 V
	Total power consumption:	160 mW (Active) ; <85 mW; (Idle)
Useful Drive Life	1.2 million device hours**	
<b>Environmental</b> (all conditions, non-condensing)	Operating Temperature:	32° to 158° F (0° to 70° C)
	Relative Humidity (operating):	5% to 95%
	Shock:	1,500 G/1.0 msec
	UL, CSA, EN 60950-2000, CISPR Pub 22 Class B, CNS 13438, AS/NZS	
Regulations	CISPR 22:2002 Class B, Korea KCC, CE Mark	
# For a city of the distance CD account	a billion bears. Asked former and one situated and the second	D f = 100 d = 1 = 7 = 1 d = 1 = 2 CCD f = 100 d = 1

<sup>\*</sup> For solid state disk drives, GB means 1 billion bytes. Actual formatted capacity is less. Up to 16GB for Windows 7 and up to 36GB for Windows 8.1 is reserved for system recovery software.\*\* The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.

### 2TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Unformatted Capacity	2 TB	
Rotational Speed	7,200 rpm	
Interface	SATA 6 Gb/s	
Cache, Multisegmented (MB)	64 MB	
Seek Time (average)	Read	<8.5 ms
	Write	<9.5 ms
Height	1.028 in/26.11 mm	
Width	4.0 in/101.6 mm	
Depth	5.787 in/146.99 mm	
Weight	1.38 lb/626 g	
Operating Temperature	41° to 131° F (5° to 55° C)	
	_	

### 1TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive

Capacity	1,000,204,886,016 bytes	
Rotational Speed	7,200 rpm	
Interface	Serial ATA 3.0 (6.0 Gb/s)	



Buffer Size	32 MB		
Logical Blocks	1,953,525,168		
, , , , ,	Single Track:	2.0 ms	
<b>Seek Time</b> (typical reads, includes controller overhead,	Average:	11 ms	
including settling)	Full-Stroke:	21 ms	
Height (nominal)	1 in/2.54 cm		
Maridae (	Media diameter: 3.5 ir	n/8.89 cm	
Width (nominal)	Physical size: 4 in/10.	2 cm	
Operating Temperature	41° to 131° F (5° to 55	° C)	
500GB 7.2K rpm SATA	6.0Gb/s 3.5" Hard Di	sk Drive	
Capacity	500,107,862,016 bytes		
Rotational Speed	7,200 rpm		
Interface	Serial ATA 3.0 (6.0 Gb/s)		
Buffer Size	16 MB		
Logical Blocks	976,773,168		
	Single Track: 2.0 ms		
<b>Seek Time</b> (typical reads, includes controller overhead,	Average:	11 ms	
including settling)	Full-Stroke:	21 ms	
Height (nominal)	1 in/2.54 cm		
	Media diameter: 3.5 in/8.89	9 cm	
<b>Width</b> (nominal)	Physical size: 4 in/10.2 cm		
Operating Temperature	41° to 131° F (5° to 55° C)		
500GB 7200 RPM SATA	2.5" Self-Encryptin	g (SED) Hard Disk Drive	
Capacity	500,107,862,016 byte	es	
Rotational Speed	7,200 rpm		
	Self-Encrypting Drive (SED) with SATA interface		



Interface	SATA 6 Gb/s		
Segmented Buffer with write cache	32768 KB - A portion of buffer capacity used for firmware		
Number of Sectors	976,773,168		
	Single Track: 1.0 ms		
Seek Time (typical reads)	Average:	13 ms	
	Full-Stroke:	25 ms	
Media Diameter	2.5 in/63.5 mm		
Height	0.267 in/6.8 mm, ±0.2r	nm	
Width	2.75 in/69.85 mm, ±0.2	25mm	
Length	3.945 in/100.2 mm, ±0.25mm		
Weight	3.35 oz/95 g (max)		
Operating Temperature	41° to 131° F (5° to 55° C)		
1TB SATA 6G 2.5" 8GB Sc	G 2.5" 8GB Solid State Hybrid Drive (SSHD)		
Formatted Capacity	1 TB		
Spindle Speed	5,400 rpm +/- 0.2%		
Drive Type	Solid State Hybrid Drive (SSHD) technology with NAND Flash		
Interface	Serial ATA (SATA)		
Cache Buffer	64 MB		
NAND Flash Commercial Multilevel Cell (cMLC)	8 GB		
Number of Sectors	976,773,168		
Sock Time (Augical was da)	Single Track: 2.0 ms		
Seek Time (typical reads)	Average:	12 ms	
Height	0.374 +/008 in (9.5 +/	- 0.2 mm)	
Width	2.750 +/- 0.010 in (69.85 +/- 0.25 mm)		



Length	3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm)		
Weight	0.254 lb/115 g (max)		
Operating Temperature	32° to 140° F (0° to 60°	C)	
500 GB SATA 6G 2.5" 8GB	Solid State Hybrid	Drive (SSHD)	
Formatted Capacity	500 GB		
Spindle Speed	5,400 rpm +/- 0.2%		
Drive Type	Solid State Hybrid Drive	(SSHD) technology with N	AND Flash
Interface	Serial ATA (SATA)		
Cache Buffer	64 MB		
NAND Flash Commercial Multilevel Cell (cMLC)	8 GB		
Number of Sectors	976,773,168		
	Single Track:	2.0 ms	
Seek Time (typical reads)	Average: 12 ms		
Height	0.268 +/008 in (6.8 +/- 0.2 mm)		
Width	2.750 +/- 0.010 in (69.85 +/- 0.25 mm)		
Length	3.951 +0.008 / -0.010 in (100.35 +0.20 / -0.25 mm)		
Weight	0.209 lb/95 g (max)		
Operating Temperature	41° to 131° F (5° to 55° (	C)	
128 GB Solid State Drive			
Unformatted Capacity	128 GB*		
Architecture	Multi Level Cell (MLC) NAND		
Interface	SATA 6 GB/sec		
Dimensions (W x H x D)	2.75 x 0.276 x 3.96 in (6.9	985 x 0.7 x 10.05 cm)	
Weight	0.16 lb (73 g)		
Bandwidth Performance	Sustained Sequential Read: Up to 450 MB/ss		



#### Technical Specifications – Hard Disk and Solid State Storage

	Sustained Sequential Write:	Up to 260 MB/s	
	Random Read (4KB):	up to 46K IOPs	
	Random Write (4KB):	up to 56K IOPs	
	Read:	55ms (TYP)	
Latency	Write:	55ms (TYP)	
Power	DC power requirement:	Min 4.5 V; Max 5.5 V	
	Total power consumption:	160 mW (Active) ; <85 mW; (Idle)	
Useful Drive Life	1.2 million device hours**		
	Operating Temperature:	32° to 158° F (0° to 70° C)	
<b>Environmental</b> (all conditions, non-condensing)	Relative Humidity (operating):	5% to 95%	
,	Shock:	1,500 G/1.0 msec	
Regulations	UL, CSA, EN 60950-2000, CISPR Pub 22 Class B, CNS 13438, AS/NZS CISPR 22:2002 Class B, Korea KCC, CE Mark		
* For colid state disk drives. CP means 1 hillion butes. TP = 1 trillion butes. Actual formatted capacity is less. Up to 25CP for Windows 9 is			

<sup>\*</sup> For solid state disk drives, GB means 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 36GB for Windows 8 is reserved for system recovery software.\*\* The product achieves a mean time between failure (MTBF) based on population statistics not relevant to individual units.

#### 500GB 2.5" FIPS 140-2 SED Solid State Drive

Formatted Capacity	500 GB			
Architecture	Self-Encrypting (SED) Sol	Self-Encrypting (SED) Solid State Drive with SATA interface.		
Interface	Serial ATA (6.0 Gb/s)	Serial ATA (6.0 Gb/s)		
Form Factor	2.5 inch	2.5 inch		
Height	6.80 mm ± 0.20			
Width	69.85 mm ± 0.25			
Length	100.35 mm ± 0.25/0.20			
Weight (typical)	<95 g (0.209 lb)			
Bandwidth Performance	Sustained data transfer rate OD 100 MB/s max			
	I/O data-transfer rate 600 MB/s max			



Power	Spinup (max): 1.00  Power consumption: Idle, active: 0.70W  Sleep 0.18W		A	
<b>Environmental</b> (all conditions, non-condensing)	Operating Temperature:		32° to 140° F (0° to 60° C)	
(att conditions, non-condensing)	Relative Humidity:		5% to 95%	
	Shock:		Maximum 400 G/2 ms	
256GB SATA 2.5" Opal2 S	SED Solid State Driv	e		
Unformatted Capacity	256 GB 500,118,192 (User Addre	ssable Sectors)		
Architecture	Self-Encrypting (SED) Solid State Drive with NAND Flash and SATA interface.  Trusted Computing Group(TCG) OPAL compliant encrypted solid state drive			
Interface	Serial ATA (6.0 Gb/s)			
Form Factor	2.5 inch			
Height	6.80 mm ± 0.20			
Width	69.85 mm ± 0.25			
Length	100.20 mm ± 0.25			
Weight	Up to 55 g			
Bandwidth Performance	Sustained Sequential Read:	Up to 520 MB/s		
	Sustained Sequential Up to 500 MB/s Write:			
Power	Power consumption:	Active: 0.78A / 3.891	W; Idle: 0.005A / 0.026W	
Mean Time Between Failure (MTBF)	1,500,000 hours			
Environmental	Operating Temperature:		32° to 158° F (0° to 70° C)	
(all conditions, non-condensing)	Relative Humidity:		5% to 95%	
	Shock:		1,500 G/0.5 ms	



Unformatted Capacity	256,186,271 user addressable sectors		
Architecture	Self-Encrypting (SED) Solid State Drive w	ith 25nm MLC NAND Flash and SATA interface	
Interface	Serial ATA 2.0 (3.0 Gb/s)		
NAND Flash	25nm MLC NAND Flash		
Height	.275 in/7mm		
Width	2.75 in/69.85 mm		
Length	3.95 in/100.5 mm		
Weight	0.161 lb (73 g)		
Bandwidth Performance	Sustained Sequential 128k Read:	Up to 450 MB/s	
	Sustained Sequential 128k Write:	Up to 260 MB/s	
	Random 4k Read:	Up to 46K IOPs	
	Random 4k Write:	Up to 56K IOPs	
Latency	Read:	55 µs	
Lutency	Write:	55 µs	
Power	SATA power consumption:  160 mW (active average); <85 average)		
Useful Drive Life	72TB written, up to 40GB/day for 5 years		
Environmental (all conditions, non-condensing)	Operating Temperature:	32° to 158° F (0° to 70° C)	
(att conditions, non-condensing)	Relative Humidity:	5% to 95%	
	Shock:	1,500 G/1 ms	

Unformatted Capacity	351,651,888 Unformatted Capacity (Total User Addressable Sectors in LBA mode)	
Architecture	Self-Encrypting (SED) Solid State Drive with 20nm MLC NAND Flash and SATA interface	
Interface	Serial ATA (6.0 Gb/s)	
NAND Flash	20nm MLC NAND Flash	



Form Factor	2.5 inch			
Thickness	7 mm			
Weight	Up to 78 g			
Bandwidth Performance	Sustained Sequential Read: Up to 540 MB/s			
	Sustained Sequential Write:	Up t	o 490 MB/s	
	Random 4k Read:	Up t	o 41K IOPs	
	Random 4k Write:	Up t	o 80K IOPs	
Power	SATA power consumption	1:	195 mW (active	average); 125 mW (idle average)
Mean Time Between Failure (MTBF)	1,200,000 hours			
Environmental	Operating Temperature:			32° to 158° F (0° to 70° C)
(all conditions, non-condensing)	Relative Humidity:			5% to 95%
	Shock:			1,500 G/0.5 ms
128GB SATA 2.5" Opal2 SED Solid State Drive				
Unformatted Capacity	128 GB 250,069,680 (User Addressable Sectors)			
Architecture	Self-Encrypting (SED) Solid State Drive with NAND Flash and SATA interface.  Trusted Computing Group(TCG) OPAL compliant encrypted solid state drive			
Interface	Serial ATA (6.0 Gb/s)			
Form Factor	2.5 inch			
Height	6.80 mm ± 0.20			
Width	69.85 mm ± 0.25			
Length	100.20 mm ± 0.25			
Weight	Up to 55 g			



Bandwidth Performance	Sustained Sequential Read:	Up to 520 MB/s	
	Sustained Sequential Write:	Up to 340 MB/s	
Power	Power consumption:	Active: 0.78A / 3.891	W; Idle: 0.005A / 0.026W
Mean Time Between Failure (MTBF)	1,500,000 hours		
<b>Environmental</b> (all conditions, non-condensing)	Operating Temperature:		32° to 158° F (0° to 70° C)
(all conditions, non-condensing)	Relative Humidity:		5% to 95%
	Shock:		1,500 G/0.5 ms
120GB SATA 2.5" Opal1 SED Solid State Drive			
Unformatted Capacity	234,442,648 Unformatted Capacity (Total User Addressable Sectors in LBA mode)		
Architecture	Self-Encrypting (SED) Solid State Drive with 20nm MLC NAND Flash and SATA interface		
Interface	Serial ATA (6.0 Gb/s)		
NAND Flash	20nm MLC NAND Flash		
Form Factor	2.5 inch		
Thickness	7 mm		
Weight	Up to 78 g		
Bandwidth Performance	Sustained Sequential Up to 540 MB/s Read:		
	Sustained Sequential Write: Up to 480 MB/s		
	Random 4k Read: Up to 41K IOPs		
	Random 4k Write:	Up to 80K IOPs	
Power	SATA power consumption	n: 195 mW (active	e average); 125 mW (idle average)
Mean Time Between Failure (MTBF)	1,200,000 hours		



Environmental (all conditions, non-condensing)	Operating Temperature:		32° to 158° F (0° to 70° C)
(all conditions, non-condensing)	Relative Humidity:		5% to 95%
	Shock:		1,500 G/0.5 ms
1TB 10K SATA 6.0Gb/s 3.	5" Hard Disk Drive		
Capacity	500,107,862,016 bytes		
Rotational Speed	7,200 rpm		
Interface	Serial ATA 2.0 (6.0 Gb/s)		
Buffer Size	16 MB		
Logical Blocks	976,773,168		
Cook Time (to reign) and de	Single Track: 2.0 ms		
Seek Time (typical reads, includes controller overhead, including settling)	Average:	12 ms	
including Settling)	Full-Stroke:	25 ms	
Height (nominal)	0.374 in/9.5 mm		
Width (nominal)	Media diameter: 2.5 in/63.5 mm		
wiutii (IIOIIIIIIat)	Physical size: 2.75 in/70 mm		
Operating Temperature	41° to 131° F (5° to 55° C)		



HP Slim SuperMulti DV	D Writer Drive		
Height	12.7mm height		
Orientation	Either horizontal or vertical		
Interface type	SATA/ATAPI		
Disc recording capacity	Up to 8.5 GB DL or 4.7 GB star	ndard	
<b>Dimensions</b> (W $\times$ H $\times$ D)	5.04 x 0.5 x 5.0 in (128 x 12.7	x 127 mm) without bezel	
Weight (max)	0.42 lb (190 g)		
	DVD-RAM	Up to 5X	
	DVD-R DL	Up to 6X	
	DVD+R	Up to 8X	
	DVD+RW	Up to 8X	
Write speeds	DVD+R DL	Up to 6X	
	DVD-R	Up to 8X	
	DVD-RW	Up to 6X	
	CD-R	Up to 24X	
	CD-RW	Up to 24X	
	DVD-RAM	Up to 5X	
	DVD-RW, DVD+RW	Up to 8X	
	DVD-R DL, DVD+R DL	Up to 8X	
Read speeds	DVD+R, DVD-R	Up to 8X	
	DVD-ROM DL, DVD-ROM	Up to 8X	
	CD-ROM, CD-R	Up to 24X	
	CD-RW	Up to 24X	
Access time	Random	DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)	
(typical reads, including	Full Stroke	DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)	
settling)	Stop Time	6 seconds (typical)	
	Source	Slimline SATA DC power receptacle	
	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p	
Power			
	DC Current	5 VDC (< 1000 mA typical, 1600 mA maximum)	
Environmental conditions	Temperature	41° to 122° F (5° to 50° C)	
(operating - non-condensing)	Relative Humidity	10% to 80%	



Maximum Wet Bulb Temperature	84° F (29° C)
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HP Slim Blu-ray BDX	(L Drive		
Height	12.7mm height		
Orientation	Either horizontal or vertical		
Interface type	SATA/ATAPI		
Disc recording capacity	Up to 128 GB QL, 100 GB	TL, 50 GB DL or 25 GB standard	i SL
<b>Dimensions</b> (W x H x D)	5.04 x 0.5 x 5.0 in (128 x	12.7 x 127 mm) without bezel	
Weight (max)	Up to 0.37 lb (170 g) witl	hout bezel	
		Triple-layer	Quadruple-layer
	BD-R	Up to 4X	Up to 4X
	BD-RE	Up to 2X	Not supported
		Single-layer	Double-layer
	BD-R	Up to 6X	Up to 6X
	BD-RE	Up to 2X	Up to 2X
	DVD-R	Up to 8X	Up to 6X
	DVD-RW	Up to 6X	Not supported
	DVD+R	Up to 8X	Up to 6X
ماريناندا معرضا ماريناندا	DVD+RW	Up to 8X	Not supported
Write speeds	DVD-RAM	Up to 5X	
	CD-R	Up to 24X	
	CD-RW	Up to 24X	
		Triple-layer	Quadruple-layer
	BD-R	Up to 4X	Up to 4X
	BD-RE	Up to 4X	Not supported
		Single-layer	Double-layer
	BD-ROM	Up to 6X	Up to 6X
	BD-R	Up to 6X	Up to 6X
	BD-RE	Up to 6X	Up to 6X
	DVD-ROM	Up to 8X	Up to 8X
Read speeds	DVD-R	Up to 8X	Up to 8X
	DVD-RW	Up to 8X	
	DVD+R	Up to 8X	Up to 8X



	DVD+RW	Up to 8X	
	BDMV (AACS Compliant Disc)	Up to 6X/2X (Read/Play)	
	DVD-RAM	Up to 5X	
	DVD-Video (CSS Compliant Disc)	Up to 8X/4X (Read/Play)	
	CD-R/RW/ROM	Up to24X	
	CD-DA(DAE)	Up to 20X/10X (Read/Play)	
Access time (typical reads, including settling)	Random	BD-ROM: 205 ms (typical), DVD-CD-ROM: 165 ms (typical)	ROM: 185 ms (typical),
	Full Stroke	BD-ROM: 350 ms (typical), DVD-CD-ROM: 340 ms (typical)	ROM: 345 ms (typical),
	Source	Slimline SATA DC power recepta	cle
Power	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p	
	DC Current	5 VDC -1200 mA typical, 2000 m	A maximum
	Temperature	41° to 122° F (5° to 50° C)	
<b>Environmental conditions</b> (operating - non-condensing)	Relative Humidity	10% to 80%	
	Maximum Wet Bulb Temperature	84° F (29° C)	

HP Slim DVD-ROM Drive			
Height	12.7mm	12.7mm	
Orientation	Either horizontal or vertical		
Interface type	SATA/ATAPI		
<b>Dimensions</b> (W x H x D)	5.04 x 0.5 x 5.0 in (128 x 12.7	7 x 127 mm) without bezel	
Weight (max)	Up to 0.37 lb (170 g) without	Up to 0.37 lb (170 g) without bezel	
	DVD+R/-R/+RW/ -RW/+R DL /-R DL	Up to 8X	
Read speeds	DVD-ROM	Up to 8X	
	CD-ROM, CD-R	Up to 24X	
	CD-RW	Up to 24X	
Access time	Random	DVD-ROM: 170 ms (typical), CD-ROM: 170 ms (typical)	
(typical reads, including settling)	Full Stroke	DVD-ROM: 320 ms (typical), CD-ROM: 320 ms (typical)	
	Source	Slimline SATA DC power receptacle	
Power	DC Power Requirement	5 VDC ± 5%-100 mV ripple p-p	
	DC Current	5 VDC - <1000 mA typical, < 1600 mA maximum	



Environmental (all conditions	Temperature	41° to 122° F (5° to 50° C)
	Relative Humidity	10% to 80%
non-condensing)	Maximum Wet Bulb Temperature (operating)	84° F (29° C)



#### Technical Specifications – Memory

#### **System Memory Support**

The HP ProDesk 400 G2 Business PC supports the 4<sup>th</sup> generation Intel® Core™ processor family. Based on a new PC micro-architecture, the processor is designed for a two-chip platform consisting of a processor and Platform Controller Hub (PCH). Unlike previous generations, the 4<sup>th</sup> generation Intel® Core™ processor includes an Integrated Memory Controller (IMC). The IMC supports DDR3/DDR3L protocols with two independent, 64-bit wide channels each accessing one or two DIMMs.

- Two channels of non-ECC DDR3/DDR3L unbuffered dual in-line memory modules (UDIMM) or DDR3/DDR3L unbuffered small outline dual in-line memory modules (SO-DIMM) with a maximum of two DIMMs per channel
- Single-channel and dual-channel memory organization modes
- Data burst length of eight for all memory organization modes
- Memory data transfer rates of up to 1600 MT/s; actual supported data transfer rate determined by the configured processor.
- 64-bit wide channels
- DDR3/DDR3L system memory I/O voltage of 1.5V
- Theoretical maximum memory bandwidth of:
  - o 21.3 GB/s in dual-channel mode assuming 1333 MT/s
  - 25.6 GB/s in dual-channel mode assuming 1600 MT/s

#### **Platform Memory Support**

The Small Form Factor (SFF) and Microtower (MT) platforms support up to two (2) industry-standard DDR3-SDRAM DIMMs.

**CAUTION:** You must shut down the computer and disconnect the power cord before adding or removing memory modules. Regardless of the power-on state, voltage is always supplied to the memory modules as long as the computer is plugged in to an active AC outlet. Adding or removing memory modules while voltage is present may cause irreparable damage to the memory modules or system board.

**NOTE:** For systems configured with more than 3 GB of memory and a 32-bit operating system, all memory may not be available due to system resource requirements. Addressing memory above 4 GB requires a 64-bit operating system.



Intel 7260 802.11 a/b/	g/n PCIe x1 WLAN Card *	
Dimensions (L × H)	0.12 x 1.06 x 1.18 in (3.1 x 26.8 x 30.0 mm)	
Chipset	Atheros AR9462	
System interface	PCI-Express Mini Card	
Network standard	802.11 a/b/g/n	
Frequency band	Wi-Fi:  802.11a/n – 4.9 – 4.95 GHz (Japan), 5.15 – 5.25 GHz, 5.25 – 5.35 GHz, 5.47 –  5.725 GHz, 5.825 – 5.850 GHz  802.11b/g/n 2.402-2.482 GHz	
Operating temperature	14° to 158°F, operating (-10° to 70°C, operating)	
Storage temperature	-40° to 176°F, non-operating (-40° to 80°C, non-operating)	
Humidity	10-90% operating 5-95% non-operating	
Operating voltage	3.3 V ±9% I/O supply voltage	
	Platform/WLAN Mode	Power Consumption
	Wi-Fi	
	Transmit Mode	2 W
	Receive Mode	1.6 W
Power Consumption	Idle mode (PSP) (WLAN Associated)	250mW
	Idle mode (WLAN unassociated)	100mW
	Radio disabled	75mW
Output Power	2.4G: +13.5dBm minimum	
	5G: +12dBm minimum	



	IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only
	802.1x authentication
Cannibu	WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES
Security	IEEE 802.11i
	Cisco Certified Extensions, all versions through CCX4 and CCX Lite
	WAPI
Antenna	2 transmit; 2 receive (2x2)

<sup>\*</sup> Wireless access point and Internet service required and not included. Availability of public wireless access points limited.

Realtek RTL8151GH-CG GbE LOM Network Adapter		
Connector	RJ-45	
System Interface	Integrated on PCA	
Controller	Realtek RTL8151GH-CG Gigabit Ethernet Controller	
Memory	16 KB FIFO packet buffer memory	
Data rates supported	10/100/1000 Mbps	
IEEE Compliance	802.1P 802.1Q 802.3 802.3ab 802.3az 802.3u	
Bus architecture	PCI Express	
Data transfer mode	PCIe-based interface for active state operation (SO state)	
Power requirement	Requires 3.3V and 1V or just 3.3V with integrated regulators Power consumption 0.425 W	
Network transfer mode	Full-duplex	
NELWOIK LIANSIEI MUAE	Half-duplex (not supported for the 1000BASE-T transceiver)	
Network transfer rate	10BASE-T (half-duplex) 10 Mbps	



	10BASE-T (full-duplex) 20 Mbps	
	100BASE-TX (half-duplex) 100 Mbps	
	100BASE-TX (full-duplex) 200 Mbps	
	1000BASE-T (full-duplex) 2000 Mbps	
Environmental	Operating Temperature: 32° to 158° F (0° to 70° C)	
Environmental	Operating Humidity:	60% RH
Management	WOL, auto MDI crossover, PXE, Muti-port teaming, Advanced cable diagnostic	

Intel® Ethernet I210-T	1 Gigabit Network Adapter	
Connector	RJ-45	
System Interface	PCI Express x1	
Controller	Intel® I210 Gigabit Ethernet Controller	
Memory	Integrated Dual 48K configurable transmit receive FIFO Buffers	
Data rates supported	10/100/1000 Mbps	
IEEE Compliance	802.1P 802.1Q 802.2 802.3 802.3AB 802.3u 802.3x flow control	
Bus architecture	PCI-E 2.1	
Data path width	X1, 250 MB/s, Bi-directional interface	
Data transfer mode	Bus-master DMA	
Hardware certifications	FCC, B, CE, TUV-c, TUVus Mark Canada and United States, TUV-GS Mark for European Union	
Power requirement	Aux 3.3 V, 3.0 Watts in 1000 base-T and 1.0 Watts in 100 Base-T	
Boot ROM support	Yes 10BASE-T (half-duplex) 10 Mbps 10BASE-T (full-duplex) 20 Mbps	



### Technical Specifications – Networking/Communication

	10BASE-T (half-duplex) 10 Mbps	
	10BASE-T (full-duplex) 20 Mbps	
Network transfer rate	100BASE-TX (half-duplex) 100 Mbps	
	100BASE-TX (full-duplex) 200 Mbps	
	1000BASE-T (full-duplex) 2000 Mbps (actual rate limited by PCI bus)	
Environmental	Operating Temperature:	32° to 132° F (0° to 55° C)
Environmentat	Operating Humidity:	85% at 131° F (55° C)
Management	WOL, PXE, DMI, WFM 2.0	

# Intel Dual Band Wireless-N 7260 802.11 a/b/g/n (2x2) Wireless Network Interface Connection

Wireless LAN Standards	IEEE 802.11a/b/g/n	IEEE 802.11a/b/g/n	
Interoperability	Wi-Fi certified (802.11 a/b/g/n WM	Wi-Fi certified (802.11 a/b/g/n WMM, WPA, WPA2 and WPS)	
	Cisco Compatible Extensions Progr XP.	am compliant with Microsoft Windows 7, Windows Vista and	
	Microsoft Windows XP. WLAN may	<b>NOTE</b> : WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista.	
Frequency Band	802.11b/g/n 2.402-2.482 GHz		
	802.11a/n	4.9 - 4.95 GHz (Japan) 5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz	
Antenna Structure	2 transmit; 2 receive (2x2)		
Data Rates	802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54	802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11n: MCS 0 ~ MCS 15, (20MHz, and 40MHz)	
Modulation		Direct Sequence Spread Spectrum CCK, BPSK, QPSK, 16-QAM, 64-QAM	



Security	<ul> <li>IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only</li> <li>AES-CCMP: 128 bit in hardware</li> <li>802.1x authentication</li> <li>WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.</li> <li>WPA2 certification</li> <li>IEEE 802.11i</li> <li>Cisco Certified Extensions, all versions through CCX4 and CCX Lite</li> <li>WAPI</li> </ul> NOTE: Check latest software/driver release for updates on supported security features.		
Sub-channels	Multinational support with frequency bands and channels compliant to local regulations.		
Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)		
Roaming	IEEE 802.11 compliant roaming between band Access Points		
Output Power	<ul> <li>2.4G: +13.5dBm minimum</li> <li>5G: +12dBm minimum</li> <li>NOTE: Maximum output power may vary by country according to local regulations.</li> </ul>		
Power Consumption	Transmit: 2.0 Watts		
·	Receive: 1.6 Watts		
	Idle mode: 250 mW (WLAN associated) In Power Save Polling mode and on battery power.		
	Idle mode: 100 mW (WLAN unassociated)		
	Radio off: 100 mW (WLAN unassociated)		
Power Management	ACPI compliant power management 802.11 compliant power saving mode		
Receiver Sensitivity	802.11g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -85 dBm (18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -76 dBm (48 Mbps), -74 dBm (54 Mbps)		
<b>NOTE</b> : Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CCK modulation) and a packet	802.11b:-95 dBm (1 Mbps), -93 dBm (2 Mbps), -91 dBm (5.5 Mbps), -88 dBm (11 Mbps) 802.11q:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -85 dBm (18 Mbps), -82 dBm		
error rate of 10% for 802.11a/g (OFDM modulation).	802.11g:-90 dBm (6 Mbps), -89 dBm (9 Mbps), -87 dBm (12 Mbps), -85 dBm (18 Mbps), -82 dBm (24 Mbps), -79 dBm (36 Mbps), -76 dBm (48 Mbps), -74 dBm (54 Mbps)		
Antenna Connections	2 U.FL type connectors (output impedance of 50 ± 2 ohms)		
Form Factors	PCI-Express Half-MiniCard		
Weight	0.0068 lb (3.1 g)		
Dimensions	0.12 x 1.06 x 1.18 in (3.1 x 26.8 x 30.0 mm)		
Operating Voltage	3.3V +/- 9%		



Temperature	Operating: Non-operating:	14° to 158° F (-10° to 70° C) -40° to 176° F (-40° to 80° C)	
Humidity	Operating: Non-operating:	10% to 90% (non-condensing) 5% to 90% (non-condensing)	
Altitude	Operating: Non-operating:	0 to 10,000 ft (3,048 m) 0 to 50,000 ft (15,240 m)	
LED Activity	LED Amber - Radio OFF; LED White - Radio ON		

Wireless LAN Standards	IEEE 802.11a/b/g/n		
Interoperability	Wi-Fi certification		
	BQE certification of the Bluetooth component		
	CCXv1, v2, v3, v4, v5 CCX certified (Cisco Client	Extensions)	
	<b>NOTE</b> : WLAN supplier's client utility is required for Cisco Compatible Extensions support with Microsoft Windows XP. WLAN may also be compatible with certain third-party software supplicants. WLAN supplier IHV extensions required for Cisco Compatible Extensions support for Microsoft Windows Vista.		
Frequency Band	802.11b/g/n	2.402-2.482 GHz	
	802.11a/n	4.9 - 4.95 GHz (Japan) 5.15 - 5.25 GHz 5.25 - 5.35 GHz 5.47 - 5.725 GHz 5.825 - 5.850 GHz	
Antenna Structure	2 transmit; 2 receive (2x2) Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications.		
Data Rates	<ul> <li>802.11b: 1, 2, 5.5, 11 Mbps</li> <li>802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps</li> <li>802.11n: card will support rates for NSS=1 and NSS=2 for RX and TX for 20 and 40 MHz channels. Short and long guard interval shall be supported.</li> </ul>		
Security	<ul> <li>IEEE and WiFi compliant 64 / 128 bit WEP encryption for a/b/g mode only</li> <li>AES-CCMP: 128 bit in hardware</li> <li>802.1x authentication</li> <li>WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES.</li> <li>WPA2 certification</li> <li>IEEE 802.11i</li> <li>Cisco Certified Extensions, all versions through V5</li> <li>WAPI</li> </ul>		



Roaming	IEEE 802.11 compliant roaming between band Access Points				
Output Power	<ul> <li>+13.5 dBm minimum</li> <li>Maximum output power must be able to achieve modular regulatory certification peak gain of +3dBi at 2.4GHz and +5dBi at 5GHz</li> </ul>				
	NOTE: Maximum o	utput power ma	y vary by country	according to local regu	ılations.
Power Consumption	Transmit: 2.0 Watts				
	Receive: 1.6 Watts				
	Idle mode: 250 mW (W	LAN associated)			
	Idle mode: 100 mW (W	LAN unassociate	d)		
	Radio off: 75 mW (WLA	N unassociated)			
Bluetooth Power	Peak operating: 330 m	W			
Consumption* *Bluetooth not supported on	Receive: 230 mW				
400 G2 Desktops	USB selective suspend	: 17 mW			
Power Management	ACPI and PCI Express bus compliant power management 802.11 compliant power saving mode Supports USB selective suspend and resume of the Bluetooth component through the USB control signals.				
Receiver Sensitivity	802.11b				
		Sensitivity (dBm)	Rate (Mbps)	Modulation and Coding Rate	
		-95 -93	2	BPSK QPSK	
		-93 -91	5.5	CCK	
		-88	11	CCK	
	802.11a/g				
		Sensitivity (dBm)	Rate (Mbps)	Modulation and Coding Rate	
		-90	6	BPSK - 1/2	
		-89	9	BPSK – ¾	
		-87	12	QPSK - ½	
		-85	18	QPSK - 3/4	
		-82	24	16 QAM – ½	
		-79 -76	36 48	16 QAM – <sup>3</sup> / <sub>4</sub> 64 QAM – 2/3	
		-76 -74	54	64 QAM – 3/4	
	002.44				
	802.11n				1
		Sensitivity (dBm)	Rate (Mbps)	Modulation and Coding Rate	
		-69	150	64 QAM – 5/6	



	-66	300	64 QAM – 5/6
Form Factors	PCI-Express Half-MiniCard		
Weight	0.1133 oz (3.212 g)		
Dimensions	1.04 x 1.17 x 0.042 in (26.65 x 29.85 x 1.067 mm)		
Operating Voltage	3.3V +/- 9%		
Temperature	Operating:       14° to 158° F (-10° to 70° C)         Non-operating:       -40° to 176° F (-40° to 80° C)		
Humidity	Operating: 10% to 90% (non-condensing) Non-operating: 5% to 95% (non-condensing)		
Altitude	Operating: Non-operating:		00 ft (3,048 m) 00 ft (15,240 m)



### Technical Specifications – Audio

### **High Definition Audio**

Туре	Integrated		
HD Stereo Codec	Realtek 2-channel ALC221 codec		
Audio I/O Ports	Front microphone-In (150-K ohm Input Impedance)		
	Rear Line-In/Microphone input (150-K ohm Input Impedance, function is configurable by audio driver)		
	Rear Line-Out* (190 ohms Output Impedance, expects at least a 10-K ohm load)		
	Front Headphone-Out (0.5 Ohm Output Impedance, expects at least a 32 ohm load) Front Microphone/Headphone jack is re-task able to provide Microphone input, line-in or Headphone output to support connecting two headphones to the front of the system. When configured as a second front headphone output, both front headphone outputs are always driven with the same signal.		
	All ports are 3.5mm		
Internal Speaker Amplifier	1.5W amplifier for the internal speaker only. External speakers must be powered externally. Rear Line-in audio port is re-taskable as either Line-in or Microphone-In.		
Multi-streaming Capable	Multi-streaming can be enabled in the Realtek control panel to allow independent audio streams to be sent to/from the front and rear jacks.		
Sampling	8 kHz - 192 kHz		
Wavetable Syntheses	Yes – Uses OS soft wavetable		
Analog Audio	Yes		
# of Channels on Line-Out	Stereo (Left & Right channels)		
Internal Speaker	Yes		
External Speaker Jack	Yes		



	Keys	104, 105, 106, 107, 109 layout (depending upon country	
Physical Characteristics	Dimensions (L x W x H)	18.22 x 6.47 x 1.1 in (46.28 x 16.43 x 2.79 cm)	
	Weight	2 lb (0.9 kg) minimum	
	Operating voltage	+ 5VDC ± 10%	
	Power consumption	50-mA maximum (with three LEDs ON)	
	System interface	PS/2 6-pin mini din connector	
	ESD	CE level 4, 15-kV air discharge	
	EMI - RFI	Conforms to FCC rules for a Class B computing device	
	Microsoft PC 99 - 2001	Functionally compliant	
Electrical	Keycaps	Low-profile design	
	Switch actuation	55-g nominal peak force with tactile feedback	
	Switch life	20 million keystrokes (using Hasco modified tester)	
	Switch type	Contamination-resistant switch membrane	
	Key-leveling mechanisms	For all double-wide and greater-length keys	
	Cable length	6 ft (1.8 m)	
	Microsoft PC 99 - 2001	Mechanically compliant	
	Acoustics	50-dBA maximum sound pressure level	
	Operating temperature	32° to 104° F (0° to 40° C)	
	Non-operating temperature	-22° to 149° F (-30° to 65° C)	
	Operating humidity	15% to 80% (non-condensing at ambient)	
Environmental	Non-operating humidity	15% to 90% (non-condensing at ambient)	
	Operating shock	N/A	
	Non-operating shock	65 inch 2.9 ms, six surface; 30g 266 inch/second; 50g 266 inch/second six surface	
	Operating vibration	2-g peak acceleration	



	Non-operating vibration	Starting at 5 Hz, vary the frequency of vibration from 5 to 500 Hz and back to 5 Hz at a Logarithmic sweep rate of 1 octave per minute.	
	Drop (out of box) 26 in (66 cm) on carpet, six-drop sequence		
	Drop (in box)	29.93 in (76 cm) on concrete, 16-drop sequence	
Approvals	CUL, ICES-003 Class B, FCC, CE Mark, TUV GS, VCCI, BSMI, C-Tick, KC		
Ergonomic compliance	ANSI HFS 100, ISO 9241-4, and TUVGS		

HP USB Smart Card (CC	ID) Keyboard		
	Protects against unauthorize	zed access with smart card technology	
	<ul> <li>Delivers even greater security when combined with a HP ProtectTools smart card and the HP ProtectTools Security Software</li> </ul>		
	Combination of username and password or pin with a smart card or security token		
Key Benefits:	Secures online transactions using digital signatures and certificates		
	Conforms to industry stand	ards for ease of setup and use	
	<ul> <li>Delivers long product life and quiet operation with high-impact materials and lubricated keys</li> </ul>		
	Spill drain feature		
	Keys	104, 105, 106, 107, 109 layout (depending upon country	
	Form factor	USB basic smart card keyboard	
Physical Characteristics	Colors	Carbonite/Silver	
	Dimensions (H x W x D)	18.2 x 6.3 x 1.3 in (46.3 x 16.1 x 3.3 cm)	
	Weight	2 lb (0.9 kg) minimum	
	Operating voltage	+ 5VDC ± 5%	
	Power consumption	100-mA maximum (with four LEDs ON)	
Electrical	System interface	USB Type A plug connector	
Liectricat	ESD	CE level 4, 15-kV air discharge	
	EMI - RFI	Conforms to FCC rules for a Class B computing device	
	Microsoft PC 99 - 2001	Functionally compliant	
Mechanical	Languages	30+ available	



	Keycaps	Standard design	
	Switch actuation	55 g nominal peak force with tactile feedback	
	Switch life	20 million keystrokes (using Hasco modified tester)	
	Switch type	Contamination-resistant membrane	
	Key-leveling mechanisms	For all double-wide and greater-length keys	
	Cable length	6 ft (1.8 m)	
	Microsoft PC 99 - 2001	Mechanically compliant	
	Acoustics	43-dBA maximum sound pressure level	
	Operating temperature	50° to 122° F (10° to 50° C)	
	Non-operating temperature	-22° to 140° F (-30° to 60° C)	
	Operating humidity	10% to 90% (non-condensing at ambient)	
	Non-operating humidity	20% to 80% (non-condensing at ambient)	
Environmental	Operating shock	40 g, six surfaces	
	Non-operating shock	80 g, six surfaces	
	Operating vibration	2-g peak acceleration	
	Non-operating vibration	4-g peak acceleration	
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence	
	Drop (in box)	42 in (107 cm) on concrete, 16-drop sequence	
	Support	All ISO 7816 smart cards (FIPS 201)	
	Interface	Reads from and writes to all ISO7816-1, 2, 3, 4 memory and microprocessor smart cards (T=0, T=1)	
	Chipset	SCM STCII	
SmartCard Function	Standard APIs supported	PC/SC, EMV2000, SET	
		USB Port	
	Power	Short circuit detection (protects smart card and reader)	



		Power supply compliant mA)	with ISO7816 and EMV (5V, 60	
		Supports 3-V and 5-V ca	upports 3-V and 5-V cards	
	Power consumption	100-mA maximum draw	1	
		From card	9600 bps to 330,000 bps	
	Communication	From computer	12 Mbps (USB transfer speed)	
		Contact device	Friction contact	
	Landing mechanism	Card insertions rating	Up to 100,000 insertion cycles	
	Interface modes	CCID protocol		
	Reader performance interface	USB connection		
		Europe	2004/108/EC	
	Electro-magnetic standards	USA	USAFCC part 15	
Approvals	CE-Mark, UL, CSA, FCC, CE Mark,	CE-Mark, UL, CSA, FCC, CE Mark, TUV, TUV GS, VCCI, BSMI, C-Tick, MIC, EMV2000,		
Ergonomic Compliance	ISO 9241-4, TUVGS			
Kit Contents	Keyboard, I/O Security and Documentation CD, warranty card			
HP USB PS/2 Washab	le Keyboard			
	Keys	104 (US) Layout, 105 (EU) l country	104 (US) Layout, 105 (EU) layout – depending upon country	
Physical Characteristics	Dimensions (L x W x H)	17.67x 6.62 x 1.38 in (449	x 168 x 35 mm)	
	Weight	1.7 lb (0.77 kg) minimum		
	Operating voltage	+ 5VDC ±5%	- 5VDC ±5%	
	Power consumption	50-mA maximum (with thr	ee LEDs ON)	
Electrical	System interface	USB Type A plug connector		
	ESD	CE level 4, 15-kV air discha	CE level 4, 15-kV air discharge	
	EMI - RFI	Conforms to FCC rules for a	Conforms to FCC rules for a Class B computing device	
	Microsoft PC 99 - 2001	Functionally compliant		
	Keycaps	Stepped -profile design		
Mechanical	Switch actuation	55-g nominal peak force w	ith tactile feedback	
	Switch life	20 million keystrokes		



### Technical Specifications - Input/Output Devices

	Switch type	Contamination-resistant switch membrane		
	Key-leveling mechanisms	For all double-wide and greater-length keys		
	Cable length	7 ft (2.2 m)		
	Microsoft PC 99 - 2001	Mechanically compliant		
	Acoustics	43-dBA maximum sound pressure level		
	Operating temperature	50° to 122° F (10° to 50° C)		
	Non-operating temperature	4° to 149° F (-20° to 65° C)		
	Operating humidity	10% to 95% (non-condensing at ambient)		
	Non-operating humidity	0% to 95% (non-condensing at ambient)		
Position and a lateral	Operating shock	40 g, six surfaces		
Environmental	Non-operating shock	80 g, six surfaces		
	Operating vibration	2-g peak acceleration		
	Non-operating vibration	4-g peak acceleration		
	Drop (out of box)	26 in (66 cm) on carpet, six-drop sequence		
	Drop (in box)	42 in (107 cm) on concrete, 16-drop sequence		
Operating system support	Windows® 7, Windows Vista, W	Windows® 7, Windows Vista, Windows XP Professional		
Approvals	UL, cUL, FCC, CE, TUV GS, VCCI, BSMI, C-Tick, KCC, USB-IF, WHQL, EN/IEC 60601-1, IP66/NEMA4X			
Ergonomic compliance	ANSI HFS 100, ISO 9241-4, and	ANSI HFS 100, ISO 9241-4, and TUVGS		

### **HP Wireless Keyboard and Mouse**

Keyboard	Dimensions (H x L x W)	1.09 x 18.1 x 6.47 in (27.87 x 460.3 x 164.3 mm)	
	Weight – Without Two AA Alkaline Batteries	1.94 lb (880 g)	
Mouse	Dimensions (H x L x W)	1.46 x 4.53 x 2.47 in (37 x 115 x 62.9 mm)	
	Weight – Without Two AA Alkaline Batteries	0.15 lb (67 g)	
Receiver	Dimensions (H x L x W)	0.33x 1.79 x 0.72 in (8.4 x 45.5 x 18.4 mm)	
	Weight	0.21 oz (5.9 g)	
	Range	32.8 ft (10 m)	
System Requirements	Windows 10, Windows 8, Windows 7 Professional Edition 32*, Windows 7 Professional Edition 64*, Windows Vista or Windows XP		



	· ·	Available USB port for the receiver CD-ROM Drive		
	* Not all features are available require upgraded and/or sepa	t all features are available in all editions or versions of Windows. Systems may ire upgraded and/or separately purchased hardware, drivers and/or software to full advantage of Windows functionality. See http://www.microsoft.com.		
Approvals	Product Safety	UL; CSA /TUV (Europe only); CE Mark; CB Report		
	Ergonomics	ANSI; ISO (Europe only); GS Mark (Germany only)		
	EMC	FCC; CE; ACA (-tick); BSMI; KC; VCCI		
	CE Mark	EN 55022:2010; EN 55024; EN 301489-1; EN 61000		
	Design Guidelines for PCs	PC 99 – connector overmold colors; PC 2001 – full functionality		
	Telecom	All local telecom requirements and approvals for intended markets		
	USA	FCC Title 47 CFR, Par 15, Subpart C; other local requirements		
	Country Support	US, Belgium, Switzerland, Spain, Denmark, Netherlands, France, Germany, Italy, Portugal, Sweden, Norway, Finland, UK, Poland, Czech Republic, Turkey, Greece, Austria, Bulgaria, Cyprus, Estonia, Hungary, Ireland, Latvia, Lithuania, Luxemburg, Malta, Romania, Slovakia, Slovenia, Vietnam, HK, Australia, NZ, Malaysia, Singapore, Indonesia, Philippines, Thailand, Canada, China, Japan, Korea, Taiwan, India, Venezuela, Ecuador, Russia, Ukraine, Israel, Croatia, United Arab Emirates, Peru, Brazil, Chile, Argentina, Mexico, South Africa, and up to 193 countries worldwide.		
Environmental	Keyboard contains 25% post-consumer recycled plastic material			
Encryption	128bit AES Encryption			

HP PS/2 Mouse	
Dimensions	1.46 x 2.48 x 4.53 in (3.70 x 6.29 x 11.50 cm)
(H x L x W)	1.40 % 2.40 % 4.35 III (3.70 % 0.25 % 1 1.30 CIII)



Weight	3.53 oz (100g; +10g/- 5 g)	3.53 oz (100g; +10g/- 5 g)		
	Operating temperature	-32° to 104°F (0° to 40° C)		
	Non-operating temperature	-4° to 140°F (-20° to 60° C)		
	Operating humidity	10% to 90% (non condensing at ambient)		
	Non-operating humidity	10% to 90% (non condensing at ambient)		
Environmental	Operating shock	40 g, 6 surfaces		
	Non-operating shock	80 g, 6 surfaces		
	Operating vibration	2 g peak acceleration		
	Non-operating vibration	4 g peak acceleration		
	Drop (out of box)	80 cm height onto asphalt tile over concrete or equivalent, 5-drop in 5 direction except the cable face		
	Operating voltage	5 VDC ± 10%		
	Power consumption	100mA		
Electrical	System consumption	PS/2 mini-din connector		
Electricat	ESD	CE level 4, 15 kV air discharge		
	EMI-RFI	Conforms to FCC rules for a Class B computing device		
	Microsoft PC99 - 2001	Functionally compliant		
	Resolution	800 DPI		
	Tracking speed	10 in/s (25.4 cm/s) maximum		
	Acceleration	±15%		
Mechanical	Switch actuation	65±20 gf		
	Switch life	3,000,000 operations (using Hasco modified tester)		
	Switch type	Low force micro-switches		
	Tracking mechanism life	80 km		
	Cable length	6 ft (1.8 m)		



	Microsoft PC99 - 2001	Mechanically compliant
	Width	6 mm
	Diameter	22.5 ± 0.2 mm
Scroll wheel	Maximum rotation force	50 gf-cm
Sciott wheet	Switch type	Light force micro-switch
	Switch life	1 million operations
	Mechanical life	Minimum 200,000 revolutions
Regulatory Approvals	UL/cUL, FCC, CE Mark, TUV/GS, VCCI, KCC, BSMI, C-Tick	

HP USB Mouse	
Dimensions (H x L x W)	1.5 x 4.5 x 2.5 in (3.7 x 11.5 x 6.3 cm)
Weight	0.22 lb (0.10 kg)
Cable length	70.9 in (180 cm)
System requirements	Available USB port

HP USB 1000dpi Laser Mouse			
Dimensions (H x L x W)	1.47 x 4.53 x 2.47 in (37.3 x 114.97 x 62.86 mm)		
Weight	3.360 oz (102g)	3.360 oz (102g)	
Cable length	70.9 in (180 cm)		
System requirements	Available USB port		
	Operating Temperature	32° to 104° F (0° to 40° C)	
Environmental	Non-operating Temperature	-4° to 140° F (-20° to 60° C)	
	Operating Humidity	10% to 90% (non-condensing at ambient)	



	Resolution	1000dpi
Mechanical	Tracking Speed	45 cm/sec
	Cable Length	70.9 in (180 cm)

HP USB PS/2 Washable Mouse			
Dimensions (H x L x W)	1.56 x 2.44 x 4.61 in	1.56 x 2.44 x 4.61 in (3.95 x 6.21 x 11.7 cm)	
Weight	4.44 oz (126 g)		
	Operating temperature	-32° to 104°F (0° to 40° C)	
	Non-operating temperature	-4° to 140°F (-20° to 60° C)	
	Operating humidity	10% to 90% (non-condensing at ambient)	
	Non-operating humidity	10% to 90% non-condensing	
Environmental	Operating shock	40 g, 6 surfaces	
	Non-operating shock	80 g, 6 surfaces	
	Operating vibration	2 g peak acceleration	
	Non-operating vibration	4 g peak acceleration	
	Drop (out of box)	80 cm height onto asphalt tile over concrete or equivalent, 5-drop in 5 direction except the cable face	
	Operating voltage	5 VDC ± 10%	
Electrical	Power consumption	100mA	
	System consumption	PS/2 mini-din connector or USB	
	ESD	CE level 2 8 kV air discharge	
	EMI-RFI	Conforms to FCC rules for a Class B computing device	



	Microsoft PC99 - 2001	Functionally compliant
	Resolution	1000 ± 20% DPI
	Tracking speed	14 in/s ( 35.56 cm/s) maximum
	Acceleration	2 g
	Switch actuation	70 g nominal peak force
Mechanical	Switch life	3,000,000 operations (using Hasco modified tester)
riechanicat	Switch type	Low force micro-switches
	Tracking mechanism life	8.8 ft total 70 cm+ 2m extension
	Cable length	Mechanically compliant
	Microsoft PC99 - 2001	1000 ± 20% DPI
	Width	6 mm
	Diameter	1 in (25.4 mm)
Scroll wheel	Maximum rotation force	48 rats/sec
	Switch type	Light force micro-switch
	Switch life	3 million operations
	Mechanical life	Minimum 200,000 revolutions
Regulatory Approvals	FCC, CE Mark, ICES-00	03-B, IP66/NEMA4X



#### Technical Specifications – Power

#### **Unit Environment and Operating Conditions**

**General Unit Operating Guidelines** 

- Keep the computer away from excessive moisture, direct moisture and the extremes of heat and cold, to ensure that unit
  is operated within the specified operating range.
- Leave a 10.2 cm (4 in) clearance on all vented sides of the computer to permit the required airflow.
- Never restrict airflow into the computer by blocking any vents or air intakes.
- Do not stack computers on top of each other or place computers so near each other that they are subject to each other's re-circulated or preheated air.
- Occasionally clean the air vents on the front, back, and any other vented side of the computer. Lint, dust and other foreign matter can block the vents and limit the airflow.
- If the computer is to be operated within a separate enclosure, intake and exhaust ventilation must be provided on the enclosure, and the same operating guidelines listed above will still apply.

Temperature Range Operating: 50° to 95° F (10° to 35° C)\*

Non-operating: -22° to 140° F(-30° to 60° C)

Relative Humidity Operating: 10% to 90% (non-condensing at ambient)

Non-operating: 5% to 95% (non-condensing at ambient)

Maximum Operating: 10,000 ft (3048 m)
Altitude (unpressurized) Non-operating: 30,000 ft (9144 m)

\*Operating temperature is de-rated 1.0 deg C per 300 m (1000 ft) to 3000 m (10,000 ft) above sea level, no direct sustained sunlight. Maximum rate of change is 10 deg C/Hr. The upper limit may be limited by the type and number of options installed.

Power Supply	MT	SFF
Standard Efficiency	300W & 180W active PFC (230 VAC input only) 300W & 180W Reg (115V/230 VAC)	240W active PFC
High Efficiency* 80 PLUS Bronze	300W & 180 active PFC ENERGY STAR® 6	240W active PFC
	82/85/82% efficient at 20/50/100% load (115V) 82/85/82% efficient at	82/85/82%efficient at 20/50/100% load (115V)
	20/50/100% load (230V)	82/85/82% efficient at 20/50/100% load (230V)
Operating Voltage Range	90 - 264 VAC	90 - 264 VAC
Rated Voltage Range	200 - 240 VAC (300W active PFC)	100 - 240 VAC
	100 - 240 VAC	
Rated Line Frequency	50/60 Hz	50/60 Hz
Operating Line Frequency	47 – 63 Hz	47 – 63 Hz
Rated Input Current	4A	4A
Rated Input Current with Energy Efficient* Power Supply	4A	4A
Current Leakage (NFPA 99)	<900uA / 230Vac (300W PSU)	< 275 μA @ 120V
Power Supply Fan	80mm Fan (300W PSU)	70mm Fan
Power cord length	6.0 ft. (1.83 m)	6.0 ft. (1.83 m)



#### **HP ProDesk 400 G2 Business Series Desktop**

#### Technical Specifications - Power

**External Power Adapter** 

Dimensions N/A N/A
Total Cord Length N/A N/A

\*High efficiency power supply is a requirement for ENERGY STAR® certification in conjunction with a select range of processors and modules



### Technical Specifications – Weights & Dimensions

Weights & Dimensions (configured with 1 HDD & 1 ODD)	мт	SFF
Chassis (W x H x D)	165 x 355 x 358.8 mm 6.49 x 13.976 x 14.126 in	337 x 100 x 380.5 mm 13.26 x 3.93 x 14.98 in
System Volume	21.02L	12.82 L
System Weight*	6.5 kg 14.33 lb	5.905 kg 13.01 lb
Max Supported Weight (desktop orientation)	N/A	35 kg
Tower Stand (H x W x D)	N/A	27.5 x 178.2 x 199 mm 1.08 x 7.01 x 7.83 in
Packaged (H x W x D)	496 x 240 x 520 mm 19.53 x 9.45 x 20.47 in	528 x 229 x 499 mm 20.78 x 9.01 x 19.64 in
		245 x 499 x 599 mm 9.64 x 19.64 x 23.58 in
Shipping Weight	Est. 9.083 kg (20.024 lb)	Est. = 9.691 kg 21.365lb
Palletization Profile	2 x 5 = 10 -units per layer 4-layer max. 40-units per pallet	SEA 4-units per layer 10-layer max. 32-units per pallet
		AIR 4-units per layer 5-layer max. 20-units per pallet



#### Technical Specifications – Miscellaneous Features

#### **Management Features**

- Advanced Configuration and Power Management Interface (ACPI). Allows the system to wake from a low power mode.
   Controls system power consumption, making it possible to place individual cards and peripherals in a low-power or powered-off state without affecting other elements of the system.
- Intel Wired for Management support; industry wide initiative to make Intel architecture based PCs, servers and mobile computers more inherently manageable out-of-the-box and over the network
- Dual State Power Button; acts as both an on/off button and a suspend-to-sleep button

#### **Serviceability Features**

- Dual colored power LED on front of computer to indicate either normal or fault condition
- Diagnostic LED Explanation Table:
  - Number of 1-second red LED blinks followed by a 2-second pause, then repeats:
    - 2 processor thermal protection activated
    - 3 processor not installed
    - 4 power supply failure
    - 5 -- memory error
    - 6 video error
    - 7 PCA failure (ROM detected failure prior to video)
    - 8 invalid ROM, boot block recovery mode
    - 9 system not fetching code
    - 10 system hang while loading an option ROM
- HP PC Hardware Diagnostics UEFI:
  - This utility enables hardware level testing outside the operating system on many components. The diagnostics can be invoked by pressing F2 at POST, and is available as a download from HP Support
- System/Emergency ROM
- Flash ROM
- CMOS Battery Holder for easy replacement
- Flash Recovery with Video Configuration Record Software
- 5 Aux Power LED on System PCA
- Processor ZIF Socket for easy Upgrade
- Over-Temp Warning on Screen (Requires IM Agents)
- Clear Password Jumper
- DIMM Connectors for easy Upgrade
- Clear CMOS Button
- NIC LEDs (integrated) (Green & Amber)
- Dual Color Power and HD LED To Indicate Normal Operations and Fault Conditions
- Color coordinated cables and connectors
- Front power switch
- System memory can be upgraded without removing the system board or any internal components
- CD & Diskette Removal
- Tool icon for easy Identification

#### **Additional Features**

#### Description

Implementation of the industry standard ATA Security feature set. When enabled, it **Drive Lock** prevents software access to user data on the drive until one or two user-defined

passwords are provided.

DPS Access through F10 Setup during Boot

**Drive Protection System**A diagnostic hard drive self test. It scans critical physical components and every sector

of the hard drive for physical faults and then reports any faults to the user



#### Technical Specifications – Miscellaneous Features

Running independently of the operating system, it can be accessed through a Windows-based diagnostics utility or through the computer's setup procedure. It produces an evaluation on whether the hard drive is the source of the problem and needs to be replaced

The system expands on the Self-Monitoring, Analysis, and Reporting Technology (SMART), a continuously running systems diagnostic that alerts the user to certain types of failures

SMART Technology (Self-Monitoring, Analysis and Reporting Technology)

Allows hard drives to monitor their own health and to raise flags if imminent failures were predicted

SMART I - Drive Failure Prediction

Predicts failures before they occur. Tracks fault prediction and failure indication parameters such as re-allocated sector count, spin retry count, calibration retry count

SMART II - Off-Line Data Collection

By avoiding actual hard drive failures, SMART hard drives act as "insurance" against unplanned user downtime and potential data loss from hard drive failure

SMART III - Off-Line Read Scanning with Defect Reallocation IOEDC: I/O Error Detection Circuitry

Detects errors in Read/Write buffers on HDD cache RAM

SMART IV - End-to-End CRC for hard drives

Interface in F10 setup provides confirmation of SMART IV support.



#### **Environmental**

#### **Environmental Data**

### Eco-Label Certifications & declarations

This product has received or is in the process of being certified to the following approvals and may be labeled with one or more of these marks:

- IT ECO declaration
- US ENERGY STAR®
- EPEAT® Gold registered in the United States. See http://www.epeat.net for registration status in your country.

#### **System Configuration**

The configuration used for the Energy Consumption and Declared Noise Emissions data for the Ultra-slim Desktop model is based on a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

#### Energy Consumption (in accordance with US ENERGY STAR® test method)

method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
Small Form Factor			
Normal Operation	22.63 W	22.11 W	22.75 W
(Short idle)			
Normal Operation	21.91 W	21.64 W	21.91 W
(Long idle)			
Sleep	1.19 W	1.28 W	1.82 W
Off	0.54 W	0.62 W	0.54 W
Microtower			
Normal Operation	21.94 W	21.08 W	22.098 W
(Short idle)			
Normal Operation	21.16 W	19.43 W	20.46 W
(Long idle)			
Sleep	1.49 W	1.60 W	1.50 W
Off	0.79 W	0.86 W	0.78 W

#### NOTE:

Energy efficiency data listed is for an ENERGY STAR® compliant product if offered within the model family . HP computers marked with the ENERGY STAR® Logo are compliant with the applicable U.S. Environmental Protection Agency (EPA) ENERGY STAR® specifications for computers. If a model family does not offer ENERGY STAR® compliant configurations, then energy efficiency data listed is for a typically configured PC featuring a hard disk drive, a high efficiency power supply, and a Microsoft Windows® operating system.

	i nerosore minaons opero	iting system.	
Heat Dissipation* Small Form Factor	115VAC, 60Hz	230VAC, 50Hz	100VAC, 60Hz
	pru/	7.0 DT11/1	70 DTU/
Normal Operation	77 BTU/hr	76 BTU/hr	78 BTU/hr
(Short idle)			
Normal Operation	75 BTU/hr	74 BTU/hr	75 BTU/hr
(Long idle)			
Sleep	4 BTU/hr	4 BTU/hr	6 BTU/hr
Off	2 BTU/hr	2 BTU/hr	2 BTU/hr
Microtower			
Normal Operation	75 BTU/hr	72 BTU/hr	76 BTU/hr
(Short idle)			
Normal Operation	72 BTU/hr	66 BTU/hr	70 BTU/hr
(Long idle)		33 2 1 3 7 1 11	
_	5 BTU/hr	5 BTU/hr	5 BTU/hr
Sleep	· · · · · · · · · · · · · · · · · · ·	· ·	The state of the s
Off	3 BTU/hr	3 BTU/hr	3 BTU/hr

\*NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level is attained for one hour.

Declared NoiseSound PowerSound PressureEmissions(LwAd, bels)(LpAm, decibels)

#### **Environmental**

(in accordance with ISO 7779 and ISO 9296) Small Form Factor		
Typically Configured — Idle	3.5	25
Fixed Disk – Random writes <b>Microtower</b>	3.6	26
Typically Configured – Idle	3.6	26
Fixed Disk – Random writes	3.6	27

#### **Longevity and Upgrading**

This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the product may include:

#### **Small Form Factor**

- 8 USB ports
- · 2 memory slots
- (1) PCI 3.0 Express x16 half-length slot
- (3) PCI Express 2.0 x1 half-length slot
- 2.5" internal storage drive
- 3.5" internal storage drive
- 1 slimdrive bay external supporting optical drive
- 1 3.5 external supporting media card reader

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

#### Microtower

- Up to 8 USB ports
- 2 memory slots
- (1) PCI 3.0 Express x16 half-length slot
- (3) PCI Express 2.0 x1 half-length slot
- (2) 3.5" internal storage drive (1 configurable as 2.5")
- 1 Slimline Drive Bay supporting an optical disk drive (optional)
- · 1 SD Reader

Spare parts are available throughout the warranty period and or for up to "5" years after the end of production.

#### **Batteries**

This battery(s) in this product comply with EU Directive 2006/66/EC

Batteries used in the product do not contain: Mercury greater the1ppm by weight Cadmium greater than 20ppm by weight

Battery size: CR2032 (coin cell)

Battery type: Lithium



#### Environmental

#### Additional Information Small Form Factor

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 14.7% post-consumer recycled plastic (by wt.)
- This product is 91.2% recycle-able when properly disposed of at end of life.

#### Additional Information Microtower

- This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC.
- This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive – 2002/96/EC.
- This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986).
- This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net
- Plastics parts weighing over 25 grams used in the product are marked per ISO11469 and ISO1043.
- This product contains 11.9% post-consumer recycled plastic (by wt.)
- This product is 90.6% recycle-able when properly disposed of at end of life.

#### **Packaging Materials**

**Material Usage** 

#### **Small Form Factor**

External:	PAPER/Corrugated	953 g
Internal:	PLASTIC/Plast. Other	196 g
	PLASTIC/Polyethylene low density	57 g
	PLASTIC/Polypropylene	13 g

The plastic packaging material is made from 10.5% recycled content.

The corrugated paper packaging materials contains at least 43.8% recycled content.

#### Microtower

External:	PAPER/Corrugated	1065 g
Internal:	PLASTIC/EPE-Expanded Polyethylene	260 g
	PLASTIC/Polyethylene low density	50 σ

The plastic packaging material is made from 7% recycled content.

The corrugated paper packaging materials contains at least 25% recycled content.

This product does not contain any of the following substances in excess of regulatory limits (refer to the HP General Specification for the Environment at

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/gse.pdf):

- Asbestos
- Certain Azo Colorants
- Certain Brominated Flame Retardants may not be used as flame retardants in plastics
- Cadmium
- Chlorinated Hydrocarbons
- Chlorinated Paraffins
- Formaldehyde
- Halogenated Diphenyl Methanes
- · Lead carbonates and sulfates



#### **Environmental**

- Lead and Lead compounds
- Mercuric Oxide Batteries
- Nickel finishes must not be used on the external surface designed to be frequently handled or carried by the user.
- Ozone Depleting Substances
- Polybrominated Biphenyls (PBBs)
- Polybrominated Biphenyl Ethers (PBBEs)
- Polybrominated Biphenyl Oxides (PBBOs)
- Polychlorinated Biphenyl (PCB)
- Polychlorinated Terphenyls (PCT)
- Polyvinyl Chloride (PVC) except for wires and cables, and certain retail packaging has been voluntarily removed from most applications.
- Radioactive Substances
- Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)

#### **Packaging Usage**

HP follows these guidelines to decrease the environmental impact of product packaging:

- Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in packaging materials.
- Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
- Design packaging materials for ease of disassembly.
- Maximize the use of post-consumer recycled content materials in packaging materials.
- Use readily recyclable packaging materials such as paper and corrugated materials.
- Reduce size and weight of packages to improve transportation fuel efficiency.
- Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.

### End-of-life Management and Recycling

Hewlett-Packard offers end-of-life HP product return and recycling programs in many geographic areas. To recycle your product, please go to: <a href="http://www.hp.com/go/reuse-recycle">http://www.hp.com/go/reuse-recycle</a> or contact your nearest HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible manner.

The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: <a href="http://www.hp.com/go/recyclers">http://www.hp.com/go/recyclers</a>. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.

Hewlett-Packard Corporate Environmental Information

For more information about HP's commitment to the environment:

Global Citizenship Report

http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html

**Eco-label certifications** 

http://www8.hp.com/us/en/hp-information/environment/ecolabels.html

ISO 14001 certificates:

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/PC\_GBU\_Product\_Design\_I SO\_14K\_Certificate.pdf

and

http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf



After-Market Options (availability may vary by region)

Business Monitors	MT	SFF	Part Number
HP ProDisplay P191	Χ	Х	C9E54AA
HP ProDisplay P201	Χ	X	C9F26AA
HP ProDisplay P221	Χ	Χ	C9E49AA
HP ProDisplay P17A	Χ	X	F4M97AA
HP ProDisplay P19A	Χ	Χ	D2W67AA
HP ProDisplay P231	Χ	Χ	E4S07AA
HP EliteDisplay E201	Χ	Χ	C9V73AA
HP EliteDisplay E221	Χ	Χ	C9V76AA
HP EliteDisplay E231	Χ	Χ	C9V75AA
HP EliteDisplay E190i	Χ	Χ	E4U30AA
HP EliteDisplay E241i	Χ	Χ	FOW81AA
HP EliteDisplay E271i	Χ	Χ	D7Z72AA
HP EliteDisplay E221c	Χ	Χ	D9E49AA
HP EliteDisplay S230tm	Χ	Χ	E4S03AA
HP L2206tm	X	X	B0L55AA
Communication Devices	MT	SFF	Part Number
Intel Ethernet I210 – T1 Gbe NIC	Х	Х	E0X95AA
Intel 7260 802.11 a/b/g/n PCIe x1 WLAN Card	Χ	X	F2P07AA
Graphics Solutions	MT	SFF	Part Number
- AMD Radeon™ HD 8350 Graphics (PCIe x16)	Х	Х	E1C63AA
AMD Radeon™ HD 8490 Graphics Card	X	X	E1C64AA
NVIDIA® NVS™ 310 Graphics (PCIe x16)	X	X	A7U59AA
NVIDIA® NVS™ 315 Graphics (PCIe x16)	X	Х	E1C65AA
HP DisplayPort Cable Kit	X	Х	VN567AA
HP DisplayPort To Dual Link DVI-D Adapter	X	Х	NR078AA
HP DisplayPort To DVI-D Adapter	Χ	Х	FH973AA
HP DisplayPort to HDMI Adapter	Χ	Х	BP937AA
HP DisplayPort To HDMI 1.4 Adapter	Χ	X	K2K92AA
HP DisplayPort to VGA Adapter	Х	X	AS615AA
HP DMS-59 to Dual DVI Cable		X	DL139A
HP DMS-59 to Dual DisplayPort Adapter		X	XP688AA
Dual Output USB Graphics Adapter	Χ	X	C5U89AA
Data Storage Drives and Accessories	MT	SFF	Part Number
HP 1-TB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive	X	X	QK555AA
HP 1-TB 10K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive	Х	X	C2T91AA
HP 500-GB 7.2K rpm SATA 6.0Gb/s 3.5" Hard Disk Drive	X	X	QK554AA
HP 128-GB SATA 3.0Gb/s Solid State Drive	X	Х	QV063AA
HP 500-GB SATA 3.0Gb/s Solid State Hybrid Drive	Χ	Χ	E1C62AA
HP Slim Removable SATA Hard Drive Enclosure (frame & carrier)	Χ	X	C1N41AA



After-Market Options (availability may vary by region)			
HP Slim Removable SATA Hard Drive Enclosure (carrier only)	x	Χ	AR639AA
HP Chassis (1bay) Security Kit	X		AR639AA
*Not available in all regions.			
Input Devices	MT	SFF	Part Number
HP USB Keyboard	Χ	X	QY776AA
HP USB Gray Keyboard (EMEA only)	X	X	B6B64AA
HP USB Smart Card (CCID) Keyboard	X	X	BV813AA
HP USB Keyboard and Mouse Kit	X	X	B1T09AA
HP USB Washable Keyboard	X	X	VF097AA
HP USB and PS/2 Washable Mouse	X	X	BM866AA
HP USB and PS/2 Washable Keyboard and Mouse Kit	X	X	BU207AA
HP PS/2 Mouse	X	X	QY775AA
HP USB Mouse	X	X	QY777AA
HP USB 1000dpi Laser Mouse	X	X	QY778AA
HP Wireless Keyboard and Mouse Combination	X	X	QY449AA
HP USB Antimicrobiall Keyboard and Mouse (China Only)	X	X	K7X25AA
System Memory	MT	SFF	Part Number
HP 4GB DDR3-1600 (PC3-12800) DIMM	X	X	B4U36AA
HP 8GB DDR3-1600 (PC3-12800) DIMM	X	Х	B4U37AA
Multimedia Devices	MT	SFF	Part Number
HP Slim DVD-ROM Drive	X	X	VP033AA
HP Slim SuperMulti DVD Writer Drive	X	X	QS209AA
HP USB HD 720P v2 Business Webcam	X	X	D8Z08AA
HP Business Headset	X	X	QK550AA
HP Business Speakers	X	X	D9J19AA
Security Devices	MT	SFF	Part Number
HP SFF Wall Mount/Security Sleeve		X	VN570AA
HP UltraSlim Cable Lock	X	Х	H4D73AA
Stands and Accessories	MT	SFF	Part Number
HP Integrated Work Center Stand (SFF)R		X	QP897AA
HP SFF Tower Stand		X	VN569AA
HP 400 Tower Bezel Kit	X	-	E1C66AA
HP (10 Sets) 400 G2 Bezel Support Kit		Х	TBD
HP Serial Port Adapter (RS-232 compatible)	X	X	PA716A
HP Parallel Port Kit	Χ	Χ	KD061AA

### LANDesk Software (E-Delivery)



#### **HP ProDesk 400 G2 Business Series Desktop**

## QuickSpecs

After-Market Options (availability may vary by region)

Contact your HP representative for available options.



#### After-Market Options (availability may vary by region)

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### **Summary of Changes**

**Summary of Changes** 

Date of change:	Version History:		Description of change:
February 23, 2015	From v1 to v2	Addition	Added "Processor support up to 84W" to at a glance section
April 22, 2015	From v2 to v3	Addition	Added, Intel® Core™ i3-4170 Processor Intel® Pentium G3470 Processor Intel® Pentium G3260 Processor
			Under Solid State Drive 128GB SATA 2.5 SSD TLC Non-SED 256GB SATA 2.5 SSD TLC Non-SED
			Added under Hard Disk SSS HP 256 GB* (non-SED) TLC Solid State Drive HP 128 GB* (non-SED) TLC Solid State Drive
July 7, 2015	From v3 to v4	Addition	Added new note under storage
		Change	Change the OS
September 9, 2015	From v4 to v5	Changed	HP WLAN 802.11 a/b/g/n 2x2 Dual Band PCIe x1 WLAN Card description updated
October 8, 2015	From v4 to From v5	Added	Added note about AMD and NVIDIA graphics cards are not available for Windows 10

